Athena II User Manual

High Integration SBC with Ethernet and Data Acquisition

Rev 1.09: April 2011

Revision	Date	Comment
1.01-1.08	9/20/10	Minor edits
1.09	5/6/11	Minor edits

TABLE OF CONTENTS

1. IMPORTANT SAFE HANDLING INFORMATION

WARNING!

ESD-Sensitive Electronic Equipment

Observe ESD-safe handling procedures when working with this product.

Always use this product in a properly grounded work area and wear appropriate ESD-preventive clothing and/or accessories.

Always store this product in ESD-protective packaging when not in use.

Safe Handling Precautions

The Helios board contains a high number of I/O connectors with connection to sensitive electronic components. This creates many opportunities for accidental damage during handling, installation and connection to other equipment. The list here describes common causes of failure found on boards returned to Diamond Systems for repair. This information is provided as a source of advice to help you prevent damaging your Diamond (or any vendor's) embedded computer boards.

ESD damage – This type of damage is usually almost impossible to detect, because there is no visual sign of failure or damage. The symptom is that the board eventually simply stops working, because some component becomes defective. Usually the failure can be identified and the chip can be replaced.

To prevent ESD damage, always follow proper ESD-prevention practices when handling computer boards.

Damage during handling or storage – On some boards we have noticed physical damage from mishandling. A common observation is that a screwdriver slipped while installing the board, causing a gouge in the PCB surface and cutting signal traces or damaging components.

Another common observation is damaged board corners, indicating the board was dropped. This may or may not cause damage to the circuitry, depending on what is near the corner. Most of our boards are designed with at least 25 mils clearance between the board edge and any component pad, and ground / power planes are at least 20 mils from the edge to avoid possible shorting from this type of damage. However these design rules are not sufficient to prevent damage in all situations.

A third cause of failure is when a metal screwdriver tip slips, or a screw drops onto the board while it is powered on, causing a short between a power pin and a signal pin on a component. This can cause overvoltage / power supply problems described below. To avoid this type of failure, only perform assembly operations when the system is powered off.

Sometimes boards are stored in racks with slots that grip the edge of the board. This is a common practice for board manufacturers. However our boards are generally very dense, and if the board has components very close to the board edge, they can be damaged or even knocked off the board when the board tilts back in the rack. Diamond recommends that all our boards be stored only in individual ESD-safe packaging. If multiple boards are stored together, they should be contained in bins with dividers between boards. Do not pile boards on top of each other or cram too many boards into a small location. This can cause damage to connector pins or fragile components.

Power supply wired backwards – Our power supplies and boards are not designed to withstand a reverse power supply connection. This will destroy each IC that is connected to the power supply (i.e. almost all ICs). In this case, the board will most likely cannot be repaired and must be replaced. A chip destroyed by reverse power or by excessive power will often have a visible hole on the top or show some deformation on the top surface due to vaporization inside the package. Check twice before applying power!

Board not installed properly in PC/104 stack – A common error is to install a PC/104 board accidentally shifted by 1 row or 1 column. If the board is installed incorrectly, it is possible for power and ground signals on the bus to make contact with the wrong pins on the board, which can damage the board. For example, this can damage components attached to the data bus, because it puts the $\pm 12V$ power supply lines directly on data bus lines.

Overvoltage on analog input – If a voltage applied to an analog input exceeds the design specification of the board, the input multiplexor and/or parts behind it can be damaged. Most of our boards will withstand an erroneous connection of up to ±35V on the analog inputs, even when the board is powered off, but not all boards, and not in all conditions.

Overvoltage on analog output – If an analog output is accidentally connected to another output signal or a power supply voltage, the output can be damaged. On most of our boards, a short circuit to ground on an analog output will not cause trouble.

Overvoltage on digital I/O line – If a digital I/O signal is connected to a voltage above the maximum specified voltage, the digital circuitry can be damaged. On most of our boards the acceptable range of voltages connected to digital I/O signals is 0-5V, and they can withstand about 0.5V beyond that (-0.5 to 5.5V) before being damaged. However logic signals at 12V and even 24V are common, and if one of these is connected to a 5V logic chip, the chip will be damaged, and the damage could even extend past that chip to others in the circuit.

Bent connector pins – This type of problem is often only a cosmetic issue and is easily fixed by bending the pins back to their proper shape one at a time with needle-nose pliers. The most common cause of bent connector pins is when a PC/104 board is pulled off the stack by rocking it back and forth left to right, from one end of the connector to the other. As the board is rocked back and forth it pulls out suddenly, and the pins at the end get bent significantly. The same situation can occur when pulling a ribbon cable off of a pin header. If the pins are bent too severely, bending them back can cause them to weaken unacceptably or even break, and the connector must be replaced.

2. INTRODUCTION

Athena II is an embedded single-board computer (SBC) in a custom PC/104 small form factor that integrates a complete embedded PC and data acquisition circuitry into a single board.

The single board Athena computer is a Pentium III class device with onboard central processing, memory and memory management devices and I/O management for specific functions. The board is larger than the PC-104 PCB format on three sides but uses the PC-104 mounting method and interface specification. The Athena II board includes the following additional features.

- Communicates externally over the ISA bus and I/O ports.
- Generates on-board RGB video for CRT display systems.
- Contains LVDS formatting to drive a flat panel
- Is powered from an externally regulated +5VDC supply.

Four models, shown in the following table, provide various speed, memory size and data acquisition options.

Model	Processor Speed	RAM Size	Data Acquisition
ATHM500-256A	500 MHz	256MB	Yes
ATHM500-256N	500 MHz	256MB	No
ATHM800-256A	800 MHz	256MB	Yes
ATHM800-256N	800 MHz	256MB	No

The Athena II CPU uses the ISA bus, internally, to connect serial ports 1 through 4 and the data acquisition circuit to the processor. The ISA bus is brought out to an expansion connector to mate with add-on boards. Diamond Systems manufactures a wide variety of compatible PC/104 add-on boards for analog I/O, digital I/O, counter/timer functions, serial ports and power supplies.

Description and Features

The Athena II board includes the following key system and data acquisition features.

Processor Section

- 800MHz Mark CPU with integrated Northbridge, downclocked as needed to reduce power consumption. 256MB RAM, system memory
- 100MHz memory bus
- 512KB 16-bit wide integrated flash memory for BIOS and user programs
- Advanced 2D/3D video graphics engine with integral MPEG-2 hardware acceleration
- 33MHz PCI Bus

I/O Section

- 2 serial ports, 460k baud max
- 2 serial ports, 115.2k baud max
- 2 ports 16550-compatible
- 2 ports 16850-compatible with 128-byte FIFOs. These ports provide RS-232, RS-422 and automatic RS-485 half-duplex capability, and RS-422/RS-485 termination
- 4 USB 1.1 ports.
- IDE drive connectors; 44 pin notebook drive or solid-state flash disk connection
- 10-/100 Base-T full-duplex PCI bus mastering Ethernet
- CRT and 24-bit dual channel LVDS flat panel support
- PS/2 keyboard and mouse ports

- ATA and UDMA/33 IDE interface.
- System status LEDs.
- Interface for amplified audio and additional LEDs.

Analog Input

- 16 single-ended/8 differential inputs, 16-bit resolution
- 100KHz maximum aggregate A/D sampling rate
- Programmable input ranges/gains with maximum range of ±10V / 0-10V
- Both bipolar and unipolar input ranges
- Autocalibration of both A/D and D/A circuits
- 10 ppm/°C drift accuracy
- Internal and external A/D triggering
- 2048-byte sample FIFO for reliable high-speed sampling and scan operation

Analog Output

- 4 analog outputs, 12-bit resolution
- ±10V and 0-10V output ranges available
- ±5V and 0-5V output range (optional)

Digital I/O

- 24 programmable digital I/O lines, 3.3V and 5V logic compatible, -0.5V to +5.5V tolerant
- Enhanced output current capability: -8/+12mA max

Counter/Timers

- 1 24-bit counter/timer for A/D sampling rate control
- 1 16-bit counter/timer for user counting and timing functions
- Programmable gate and count enable
- Internal and external clocking capability

System Features

- Plug and play BIOS with IDE auto detection, 32-bit IDE access, and LBA support
- User-selectable COM1 or COM2 terminal mode
- On-board lithium backup battery for real-time-clock and CMOS RAM
- ATX power switching capability.
- Programmable watchdog timer
- Power supply: 5VDC operation from the PC/104 bus or a power connector
- Extended temperature range operation: -40°C to +85°C

3. FUNCTIONAL OVERVIEW

3.1   Functional Block Diagram
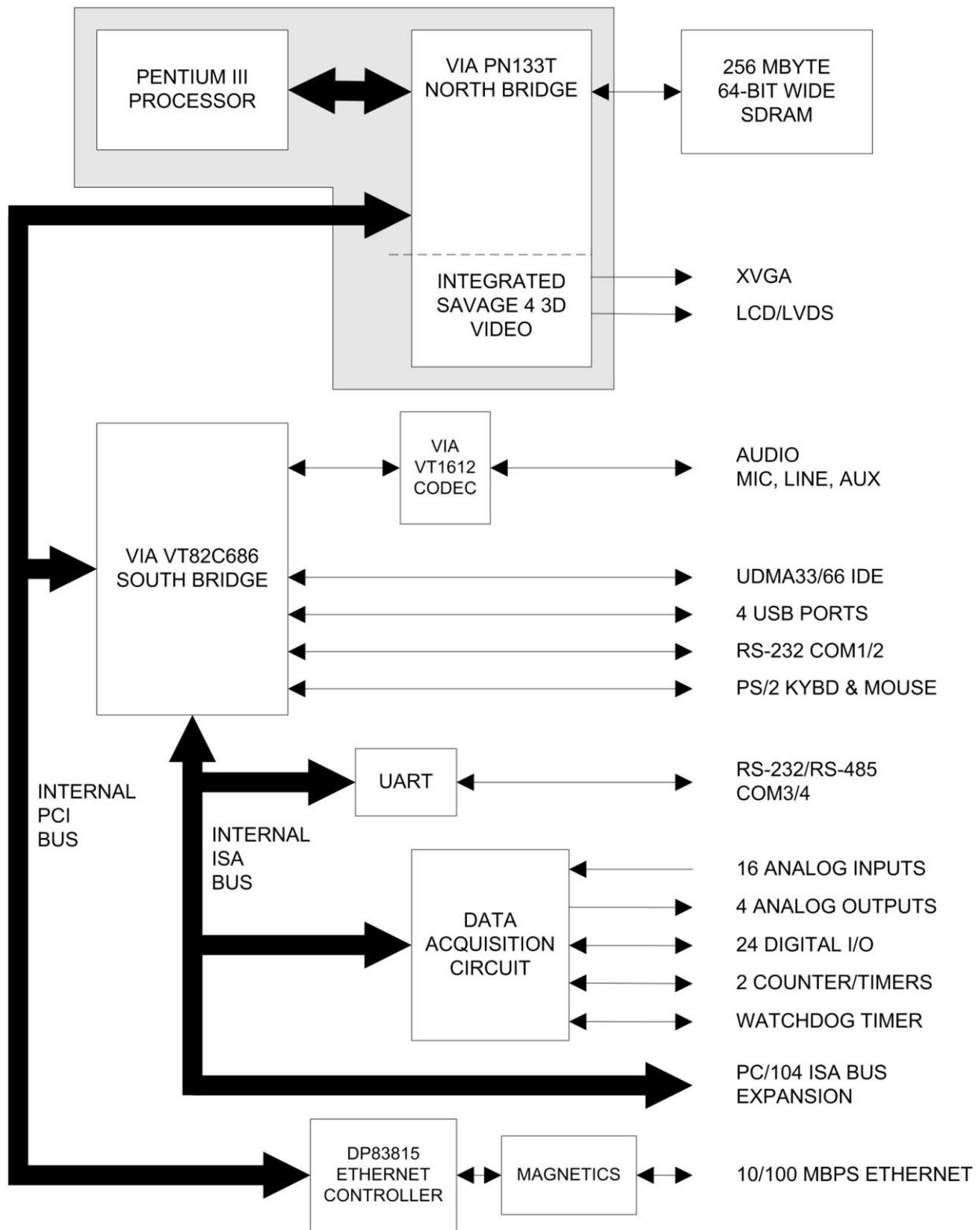
3.2   Functional Overview

This section describes the major Athena II subsystems.

3.2.1   Processor

The board uses the VIA Mark integrated processor, with integrated Northbridge, up to the rated processor speed of 500/800MHz.

An appropriate heat sink is required, depending on the processor speed. The design supports a 5VDC fan with speed sensing. A connector is provided for this purpose.

3.2.2   Southbridge

The VIA VT82C686 provides the ISA bus, audio, UDMA33/66 IDE, four USB 1.1 ports, two RS-232 ports and a PS/2 keyboard/mouse interface.

3.2.3   Memory

The 64-bit wide 256MB SDRAM operates at 100MHz for all configurations. No expansion connector is provided for additional memory.

The board also includes flash memory for BIOS and user program storage. Flash memory is accessible through the on-board ISA bus.

3.2.4   Video Features

Video circuitry is provided by the VIA Mark chipset.

3.2.5   Audio

The design provides AC97 audio support derived from the Southbridge chip. The Via VT1612A CODEC provides audio processing.

Audio I/O includes:

- Stereo line in
- Stereo line out
- Mono mic in
- Stereo internal line in

The board includes audio power amplifier circuitry for stereo speaker output. The amplifier circuit is powered by +5VDC from the board. User DC control of volume is also provided, which overrides the software settings.

3.2.6   Ethernet

The board supports 10-/100- Base-T Ethernet. Magnetics are included on the board so that a complete circuit is provided.

3.2.7   Data Acquisition

The board provides the following data acquisition capabilities.

Type of I/O	Characteristics
Analog Input	16 single-ended/8 differential inputs,16-bit resolution. 100KHz maximum aggregate A/D sampling rate. Programmable input ranges/gains: +/-10V, +/-5V, +/-2.5V, +/-1.25V, 0-10V, 0-5V, 0-2.5V. A/D FIFO for reliable high-speed sampling and scan operation.
Analog Output	Four analog outputs, 12-bit resolution. ±10V and 0-10V output ranges. Indefinite short circuit protection on outputs.
Digital I/O	24 programmable digital I/O, 3.3V and 5V logic compatible.
Counter/Timers	One 24-bit counter/timer for A/D sampling rate control. One 16-bit counter/timer for user counting and timing functions.

On board I^2C flash EEROM is provided for auto-calibration value storage.

3.2.8   Standard Peripherals

The board provides the following standard system peripherals.

Peripheral	Characteristics
Serial ports	Four serial ports
PS/2 ports	Keyboard and mouse
USB ports	Four USB 1.1 ports
IDE ports	One 44-pin connector for HDD or compact flashdisk socket

Athena II contains four serial ports. Each port is capable of transmitting at speeds of up to 115.2Kbaud, and uses a dedicated RS-232 transceiver with ESD protection.

Ports COM1 and COM2 are built into the standard chipset, consisting of standard 16550-type UARTs with 16-byte FIFOs.

Ports COM3 and COM4 are derived from a dual UART chip, which includes 128-byte FIFOs. These ports may be operated at speeds up to 460Kbaud with the installation of high-speed drivers as a custom option. COM3 and COM4 can also be BIOS-selected for RS-232 or RS-485. Termination resistors can be jumper-enabled on these two ports.

Console redirection feature is incorporated. This feature enables keyboard input and character video output to be routed to one of the serial ports.

The board contains provision for mounting a solid state IDE flash disk module with capacities ranging from 32MB and greater. The module mounts onto the board using a 44-pin 2mm pitch header and a hold-down mounting hole with spacer and screws.

3.2.9 Bus Interfaces

The PCI bus is generated by the VIA Mark processor module and is used internally for the Ethernet circuit. The PCI bus is not brought out to a PCI-104 expansion connector.

The Southbridge also provides the ISA bus, which is extended to the PC/-104 interface, ,providing the following I/O.

- Dual UART for 2 serial ports
- Data acquisition circuit, including a watchdog timer, analog and digital I/O, and two counter/timers

3.2.10 Power Supply

The power supply needs to supply an input voltage of +5VDC, ±5%, either from the PC/104 bus or from the on-board connectors.

The power supply includes ATX power switching and ACPI power management support.

Note: The ATX power switch does not control the master +5V on the board.

3.2.11 Battery Backup

Athena II contains a backup battery for the real-time clock and BIOS settings. The battery is directly soldered to the board and provides a minimum 7 year backup lifetime at 25°C.

The on-board battery may be replaced with an external battery connected to an external battery connector.

The board can operate with no battery as well by putting a jumper on J10 pins 13 and 14 (CMOS/BAT). In any operation without a battery, the CMOS contents will not be maintained after rebooting the system.

3.2.12 Watchdog Timer

A watchdog timer (WDT) circuit consists of two cascaded programmable timers, which may be triggered in hardware or software.

4. BOARD DESCRIPTION

The figure below shows the Athena II board layout, including connectors, jumper blocks and mounting holes.
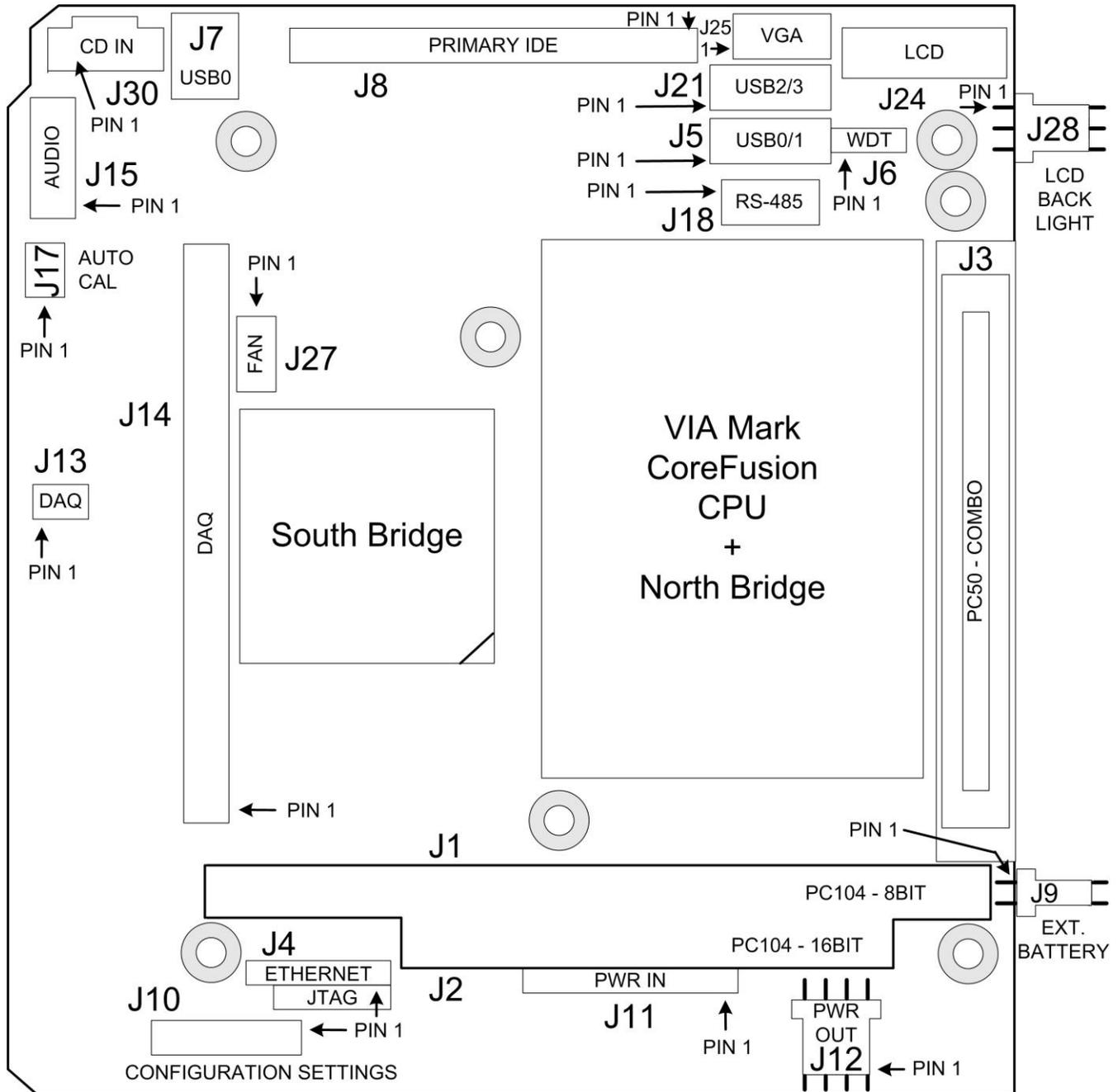
4.1   Connector Summary

The following table lists the connectors on the Athena II board.

Connector	Description
J1	PC/104, ISA bus A,B
J2	PC/104, ISA bus C,D
J3	Main I/O (serial ports, PS/2 keyboard/mouse, parallel port, utility)
J4	Ethernet
J5	USB 0/1
J6	Watchdog/Failsafe Features
J7	USB0 (mini-USB connector)
J8	Primary IDE (44-pin, laptop)
J9	External Battery
J11	Input Power
J12	External Auxiliary Power (output)
J14	Data Acquisition I/O
J15	Audio I/O
J17	Auto-calibration Reference Voltage
J21	USB 2/3
J24	LVDS LCD
J25	VGA
J27	CPU Fan
J28	LCD Backlight Power
J30	CD Input

4.1.1   Jumper Summary

The following table lists the jumpers on the Athena II board.

Jumper	Description
J10	System configuration (SBC features)
J13	Data acquisition circuit configuration
J18	RS-485 Mode Selection, COM 3/4

5. CONNECTORS

This section describes the on-board Athena II connectors.

> **Note:** All cables mentioned in this chapter are included in Diamond Systems' cable kit C-ATH-KIT. Some cables are also available individually.

5.1 PC/104 ISA Bus (J1, J2)

Connectors J1 and J2 carry the ISA bus signals. The following diagram shows the PC/104 A and B pin layout for J1 and the C and D pin layout for J2.

	J1					J2		
IOCHCHK-	A1	B1	Ground	Ground	C0	D0	Ground
SD7	A2	B2	RESETDRV	SBHE-	C1	D1	MEMCS16--
SD6	A3	B3	+5V	LA23	C2	D2	IOCS16-
SD5	A4	B4	IRQ9	LA22	C3	D3	IRQ10
SD4	A5	B5	-5V	LA21	C4	D4	IRQ11
SD3	A6	B6	DRQ2	LA20	C5	D5	IRQ12
SD2	A7	B7	-12V	LA19	C6	D6	IRQ15
SD1	A8	B8	ENDXFR-	LA18	C7	D7	IRQ14
SD0	A9	B9	+12V	LA17	C8	D8	DACK0-
IOCHRDY	A10	B10	Key	MEMR-	C9	D9	DRQ0
AEN	A11	B11	SMEMW-	MEMW-	C10	D10	DACK5-
SA19	A12	B12	SMEMR-	SD8	C11	D11	DRQ5
SA18	A13	B13	IOW-	SD9	C12	D12	DACK6-
SA17	A14	B14	IOR-	SD10	C13	D13	DRQ6
SA16	A15	B15	DACK3-	SD11	C14	D14	DACK7-
SA15	A16	B16	DRQ3	SD12	C15	D15	DRQ7
SA14	A17	B17	DACK1-	SD13	C16	D16	+5
SA13	A18	B18	DRQ1	SD14	C17	D17	MASTER-
SA12	A19	B19	REFRESH-	SD15	C18	D18	Ground
SA11	A20	B20	SYSCLK	Key	C19	D19	Ground
SA10	A21	B21	IRQ7				
SA9	A22	B22	IRQ6				
SA8	A23	B23	IRQ5				
SA7	A24	B24	IRQ4				
SA6	A25	B25	IRQ3				
SA5	A26	B26	DACK2-				
SA4	A27	B27	TC				
SA3	A28	B28	BALE				
SA2	A29	B29	+5V				
SA1	A30	B30	OSC				
SA0	A31	B31	Ground				
Ground	A32	B32	Ground				

5.2   Main I/O (J3)

An 80-pin high-density connector, J3, is provided for access to the user I/O.   The following functions are supported by this connector.

- Two serial ports
- Parallel port
- Watchdog timer I/O
- PS/2 keyboard
- PS/2 mouse
- IrDA port
- ATX Power switch
- Reset switch
- Power and HDD LEDs

J3 Main I/O Connector
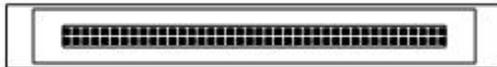
Cable A				Cable B	
COM1	DCD1	1	1	STB-	*LPT1*
	DSR1	2	2	AFD-	
	RXD1	3	3	PD0	
	RTS1	4	4	ERR-	
	TXD1	5	5	PD1	
	CTS1	6	6	INIT-	
	DTR1	7	7	PD2	
	RI1	8	8	SLIN-	
	GND	9	9	PD3	
COM2	DCD2	10	10	GND	
	DSR2	11	11	PD4	
	RXD2	12	12	GND	
	RTS2	13	13	PD5	
	TXD2	14	14	GND	
	CTS2	15	15	PD6	
	DTR2	16	16	GND	
	RI2	17	17	PD7	
	GND	18	18	GND	
COM3	DCD3	19	19	ACK-	
	DSR3	20	20	GND	
	RXD3	21	21	BUSY	
	RTS3	22	22	GND	
	TXD3	23	23	PE	
	CTS3	24	24	GND	
	DTR3	25	25	SLCT	
	RI3	26	26	KB Clk	*KYBD*
	GND	27	27	KB/MS V-	
COM4	DCD4	28	28	KB Data	
	DSR4	29	29	KB/MS V+	
	RXD4	30	30	MS Clk	*Mouse*
	RTS4	31	31	KB/MS V-	
	TXD4	32	32	MS Data	
	CTS4	33	33	KB/MS V+	
	DTR4	34	34	GND	*Utilities B*
	RI4	35	35	Reset-	
	GND	36	36	ATX Power	
Utilities A	+5V Out	37	37	KB Lock	
	Speaker Out	38	38	IR RX	
	IDE Drive LED	39	39	IR TX	
	Power LED	40	40	+3VSB	

Signal Group	Signal	Description
COM1-COM4	-	The signals on these pins are RS-232 level signals and may be connected directly to RS-232 devices. The pinout of these signals is designed to allow a 9-pin male IDC connector to be crimped onto the corresponding ribbon cable wires to provide the correct pinout for a PC serial port connector (DTE).
LPT1	-	*The signals on these pins comprise a standard PC parallel port. The pinout of these signals is designed to allow a 25-pin female IDC connector to be crimped onto the corresponding ribbon cable wires to provide the correct pinout for a PC parallel port connector.*
KYBD, Mouse	-	PS/2 signals for keyboard and mouse. (Pins 2 and 6 on the Mini-Din-6 PS/2 connectors are unused).
	KB Clk	Clock pin; connects to pin 5 of the PS/2 connector.
	KB/MS V-	Power pin; connects to pin 3 of the PS/2 connector.
	KB Data	Data pin; connects to pin 1 of the PS/2 connector.
	KB/MS V+	Power pin; connects to pin 4 of the PS/2 connector.
Utilities A	+5V Out	Switched power pin that is turned on and off with the ATX power switch or with the +5V input.
	Speaker Out	Referenced to +5V Out. Connect a speaker between this pin and +5V Out.
	IDE Drive LED	Referenced to +5V Out. Does not require a series resistor. Connect LED directly between this pin and +5V Out.
	Power LED	Referenced to +5V Out. Does not require a series resistor. Connect LED directly between this pin and +5V Out.
Utilities B	Reset-	Connection between this pin and Ground will generate a Reset condition.
	ATX Power	When ATX is enabled, a momentary contact between this pin and ground causes the CPU to turn on, and a contact of 4 seconds or longer will generate a power shutdown. ATX power control is enabled with a jumper on jumper block J10.
	KB Lock	When this pin is connected to Ground, the keyboard and mouse inputs are ignored.
	IR RX, IR TX	IrDA pins. Can be connected directly to an IrDA transceiver.
	+3VSB	Connected to +5V input power on J11. This pin is not switched by ATX control. This pin is provided for auxiliary use such as front panel lighting or other circuitry at the user's discretion.

Connector J3 mates with Diamond Systems cable no. C-PRZ-01, which consists of a dual-ribbon-cable assembly with industry-standard connectors at the user end. The SBC mating connector includes integral latches for enhanced reliability. Each ribbon cable has 40 wires.

5.3 Ethernet (J4)

Ethernet connectivity is provided by 1x6-pin connector J4. Connector J4 mates with Diamond Systems cable number C-PRZ-02, which provides a panel-mount RJ-45 jack for connection to standard CAT5 network cables.

J4 Ethernet Connector

Pin	Signal
1	Common
2	RX-
3	Common
4	RX+
5	TX-
6	TX+

5.4 USB (J5, J21)

Connectors J5 (USB 0/1) and J21 (USB 2/3) provide four USB 1.1 ports.

J5/J21 USB Connectors
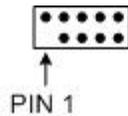
Signal	Pin	Pin	Signal
(J5-only) Key (pin cut)	1	2	Shield (J5-only)
GND	3	4	GND
USB1/3 D+	5	6	USB0/2 D+
USB1/3 D-	7	8	USB0/2 D-
USB1/3 VCC	9	10	USB0/2 VCC

Signal	*Definition*
VCC	+5VDC
D-	Data +
D+	Data -
GND	Ground

Connectors J5 and J21 mate with Diamond Systems cable no. 698012, which provides two standard USB type A jacks in a panel-mount housing.

Note: USB0 (J7) shares the J5 USB circuitry. Do not connect USB devices to both USB0 and J5.

5.5   Watchdog Timer (J6)

J6 Watchdog Timer Access Connector
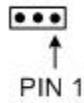
Connector J6 is used for watchdog timer access..

1	GND
2	WDI
3	WDO

Signal	Definition
WDI	Watchdog Timer Input
WDO	Watchdog Timer Output
GND	0V (ground) power return path.

Note: The watchdog timer circuit may be programmed either directly as described in this manual, or with the Diamond Systems Universal Driver software.

5.6 USB0 (J7)

Connector J7 (USB0) is a mini-USB connector that provides a single, quick and simple on-board USB connection for simple test and development without requiring an additional cable.

J7 USB0 Connector (end view)

PIN 1
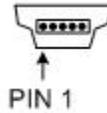
1	VCC
2	D-
3	D+
4	(not used)
5	GND

Signal	*Definition*
VCC	+5VDC
D-	Data +
D+	Data -
GND	Ground

Note: USB0 shares the J5 USB circuitry. Do not connect USB devices to both USB0 and J5.

5.7 IDE (J8)

Connector J8 is a 2x22-pin header used for an IDE connection. An associated mounting hole is provided to install a flash disk module.

J8 IDE Connector

PIN 1

Reset -	1	2	Ground
D7	3	4	D8
D6	5	6	D9
D5	7	8	D10
D4	9	10	D11
D3	11	12	D12
D2	13	14	D13
D1	15	16	D14
D0	17	18	D15
Ground	19	20	Key (pin cut)
DRQ	21	22	Ground
IDEIOW-	23	24	Ground
IDEIOR-	25	26	Ground
IORDY	27	28	Ground
DACK-	29	30	Ground
IRQ14	31	32	Pulled low for 16-bit operation
A1	33	34	Not used
A0	35	36	A2
CS0-	37	38	CS1-
LED-	39	40	Ground
+5v	41	42	+5v
Ground	43	44	Not used

Connector J8 mates with Diamond Systems cable no. 698004, and may be used to connect up to two IDE drives (hard disks, CD-ROMs, or flash disk modules). The 44-pin connector includes power and mates directly with notebook drives and flash disk modules. To use a standard format hard disk or CD-ROM drive with a 40-pin connector, an adapter PCB such as Diamond Systems ACC-IDEEXT is required.

> **Note:** Connector J8 supports only up to ATA-33 (UDMA-2). It does not support ATA-66 (UDMA-3 to 5) transfer modes.

5.8 External Battery (J9)

Connector J9 is used to connect an external battery for maintaining the Real-Time Clock and the CMOS settings (BIOS settings for various system configurations). The battery voltage for this input should be 3-3.6VDC. The current draw averages under 4µA at 3V.

J9 External Battery Connector (end view)

1	Battery input (+)
2	Ground

5.9 Input Power (J11)

Input power for Athena II may be supplied either from an external supply, through J11, or directly through the PC/104 bus power pins if a PC/104 power supply is used with the CPU.

J11 Input Power Connector

PIN 1
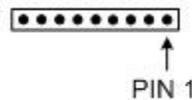
1	+5V In
2	Ground
3	Key (pin cut)
4	+12V In
5	Ground
6	+5V In
7	-12V In
8	-5V In
9	ATX Control

- Input power for Athena may be supplied either through J11 from an external supply or directly through the PC/104 bus power pins if a PC/104 power supply is used with the CPU.
- Athena requires only +5VDC input power to operate. All other required voltages are generated on board with miniature switching regulators. However since the PC/104 bus includes pins for ±5V and ±12V, these voltages may be supplied through J11 if needed. The +5V and +12V voltages are controlled by the ATX power manager switches, while -5V and -12V are routed directly to the corresponding pins on PC/104 bus and are not controlled by the ATX function.

- Make sure that the power supply used has enough current capacity to drive your system. The Athena II SBC requires up to 2A on the +5V line for the 500MHz configuration (3.0A for the 800MHz configuration.) If you have a disk drive or other modules connected, you need additional power. In particular, many disk drives need extra current during startup. If your system fails to boot properly, or if disk accesses do not work properly, the first thing to check is the power supply voltage level. Many boot-up problems are caused simply by insufficient voltage due to excess current draw on the +5V supply.

- Multiple +5V and Ground pins are provided for extra current carrying capacity if needed. Each pin is rated at 3A max (15W). For the Athena II SBC and panel I/O board 2A is sufficient, so +5V and Ground require only a single wire each. In this case the first 4 pins may be connected to a standard 4-pin miniature PC power connector if desired. Be advised that some voltage will be dropped in the wire depending on the wire gauge (AWG).

- For a larger PC/104 stack the total power requirements should be calculated to determine whether additional wires are necessary.

- ATX control enables the +5V and +12V power to be switched on and off with an external momentary switch. A short press on the switch will turn on power, and holding the switch on for 4 seconds or longer will turn off power.

- Diamond Systems' cable no. 698009 mates with J11. It provides 9 color-coded wires with stripped and tinned leads for connection to user-supplied power sources. When used, make sure the two red +5V wires are both connected to +5V.

5.10   External Auxiliary Power, Output (J12)

Connector J12 provides switched power for use with external drives. If ATX is enabled, the power is switched ON and OFF with the ATX input switch. If ATX is not enabled, the power is switched ON and OFF in conjunction with the external power.

J12 Auxiliary Power Output Connector (end-on view)

 ← PIN 1

1	+5V (switched)
2	GND
3	GND
4	+12V (switched)

Signal	*Definition*
+5V	This is provided by the on-board power supply, derived from the input power. It is switched off when the board is powered down.
+12V	This is provided by the 12V input pin on the main power connector. It is switched off when the board is powered down.
GND	These are 0V ground references for the power output voltage rails, above.

Diamond Systems cable number 698006 mates with connector J12. This cable provides a standard full-size power connector for a hard drive or CD-ROM drive and a standard miniature power connector for a floppy drive.

5.11   Data Acquisition, Digital I/O (J14)

J14 Digital I/O Connector

PIN 1
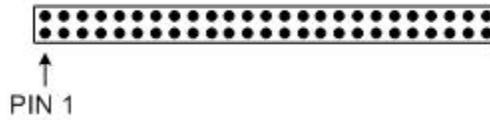
Athena II includes a 50-pin header, J14, for all data acquisition I/O.

DIO A0	1	2	DIO A1
DIO A2	3	4	DIO A3
DIO A4	5	6	DIO A5
DIO A6	7	8	DIO A7
DIO B0	9	10	DIO B1
DIO B2	11	12	DIO B3
DIO B4	13	14	DIO B5
DIO B6	15	16	DIO B7
DIO C0	17	18	DIO C1
DIO C2	19	20	DIO C3
DIO C4/GATE0	21	22	DIO C5/GATE1
DIO C6/CLK1	23	24	DIO C7/OUT0
EXTTRIG	25	26	TOUT1
+5V out	27	28	DGND
VOUT0	29	30	VOUT1
VOUT2	31	32	VOUT3
AGND(Vout)	33	34	AGND(Vin)
VIN0	35	36	VIN8
VIN1	37	38	VIN9
VIN2	39	40	VIN10
VIN3	41	42	VIN11
VIN4	43	44	VIN12
VIN5	45	46	VIN13
VIN6	47	48	VIN14
VIN7	49	50	VIN15

Signal	Definition
DIO A7-A0	Digital I/O port A; programmable direction.
DIO B7-B0	Digital I/O port B; programmable direction.
DIO C7-C0	Digital I/O port C; programmable direction. C7-C4 may be configured for counter/timer signals.
EXTTRIG	External A/D trigger input.
TOUT1	Counter/Timer 1 output.
Vin 7/7+ ~ Vin 0/0+	Analog input channels 7 – 0 in single-ended mode. High side of input channels 7 – 0 in differential mode.
Vin 15/7- ~ Vin 8/0-	Analog input channels 15 – 8 in both single-ended mode. Low side of input channels 7 – 0 in differential mode.
VOUT0-3	Analog output channels 0 – 3.
+5V out	Connected to switched +5V supply (Output only! Do not connect to external supply).
DGND	Digital ground (0V - reference); used for digital circuitry only.
AGND	Analog ground; used for analog circuitry only. Vout pin is for analog outputs, Vin pin is for analog inputs.

Diamond Systems cable no. C-50-18 provides a standard 50-pin connector at each end and mates with this header.

5.12 Speaker (J15)

Connector J15 is a 2x5-pin header used to connect speakers.

J15 Speaker Connector

PIN 1
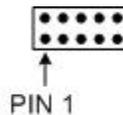
Left headphone, line out	1	2	Right headphone, line out
Audio ground	3	4	Line input, left
Line input, right	5	6	Audio ground
Microphone input	7	8	Power reference for microphone
Key (pin cut)	9	10	Audio ground

The volume control is capable of 32 discrete levels, ranging from a 20dB maximum gain to -85dB (Muted). The main volume control is the "MID" line, which may be tied to the center tap of a potentiometer with "HIGH" on one side and "LOW" on the other to give a full range of power control.

- Shorting "MID" to "LOW" mutes the speaker audio
- Shorting "MID" to "HIGH" provides maximum gain
- Default (no connection) provides 10dB of gain

The maximum output power is specified to provide up to two Watts into a 4-Ohm speaker load. Note that this output power is drawn from the on-board 5V supply.

The speakers are driven using a Bridged-Tied Load (BTL) amplifier configuration. This is a differential speaker connection. As such, each speaker should be wired directly to the appropriate pair of connections for that speaker.

- Do not connect the speaker low sides (-) to ground
- Do not short the speaker low connections together

5.13   Auto-Calibration Reference Voltage (J17)

Connector J17 is a two-pin header used for auto-calibration.

1	GND
2	AutoCal Reference Value

The Diamond Systems AutoCal routines read the exact voltage calibration values from the AutoCal-Flash. There are four analog values that need to be measured and stored in the AutoCal flash during manufacturing test. Those values are produced from a very stable power source.

The values stored to AutoCal flash can be measured at header J17, where pin 1 is ground and pin 2 is one of the positive values shown in the following table, depending on the selection of the Cal-Mux. The table gives the approximate values of the four AutoCal values.

Cal-Mux	Value
0	5.5mV
1	1.2V
2	2.48V
3	4.96V

Note: Disconnect the measurement cables after measuring the voltages and before initiating the actual auto-calibration.

5.14 LCD Panel, LVDS Interface (J24)

Connector J24 provides access to the internal LVDS LCD display drivers. Note that the LCD also requires the backlight to be connected (J28, below) to function correctly.

J24 LCD Panel Connector

Ground	1	2	Ground
LCD1 clock-	3	4	LCD2 clock-
LCD1 clock+	5	6	LCD2 clock+
Ground	7	8	Ground
LCD1 data 0-	9	10	LCD2 data 0-
LCD1 data 0+	11	12	LCD2 data 0+
Ground	13	14	Ground
LCD1 data 2-	15	16	LCD2 data 1-
LCD1 data 2+	17	18	LCD2 data 1+
Ground	19	20	Ground
LCD1 data 1-	21	22	LCD2 data 2-
LCD1 data 1+	23	24	LCD2 data 2+
Ground	25	26	Ground
VDD (LCD display)	27	28	VDD (LCD display)
VDD (LCD display)	29	30	VDD (LCD display)

Signal	Definition
LCD1 Data 0-2 +/-	Primary Data Channel, bits 0-2 (LVDS Differential signaling)
LCD1 Clock +/-	Primary Data Channel, Clock (LVDS Differential signaling)
LCD2 Data 0-2 +/-	Secondary Data Channel, bits 0-2 (LVDS Differential signaling)
LCD2 Clock +/-	Secondary Data Channel, Clock (LVDS Differential signaling)
VDD	+3.3V Switched Power Supply for LCD display (only powered up when LCD display is active)
Ground	Power Ground, 0V

5.15   VGA (J25)

Connector J25 is a 2x4-pin header for connecting a VGA monitor.

J25 VGA Connector

Pin 1 →
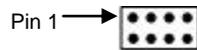
Red	1	2	Green
Ground	3	4	Blue
DDC data	5	6	HSYNC
DDC clock	7	8	VSYNC

Signal	*Definition*
Ground	Ground return
Red	RED signal (positive, 0.7Vpp into 75 Ohm load)
Green	GREEN signal (positive, 0.7Vpp into 75 Ohm load)
Blue	BLUE signal (positive, 0.7Vpp into 75 Ohm load)
DDC clock/data	Digital serial I/O signals used for monitor detection (DDC1 specification)
HSYNC	Horizontal sync
VSYNC	Vertical sync

Note: While the DDC serial detection pins are present, a 5V power supply is not provided (the old "Monitor ID" pins are also not used).

Diamond Systems cable assembly 6981030 provides a female DB15 connection to interface with a standard RGB monitor.

5.16 CPU Fan (J27)

Connector J27 is used to connect to the SBC fan.

J27 CPU Fan Connector

1	Fan RPM
2	GND
3	+5v

Signal	Definition
Fan RPM	TTL signal input that pulses with each revolution of the fan.
+5	Power Supply for optional CPU Fan, if necessary.
GND	Ground

5.17 LCD Backlight (J28)

Connector J28 provides the backlight power and control for the optional LCD panel. See the description for connector J24, above, for details on the LCD data interface.

J28 LCD Backlight Connector (end view)
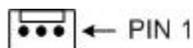
1	+12v
2	Control
3	Ground

Signal	Definition
+12V	Power supply for LCD Backlight assembly
Control	Output signal (from Athena II) to allow power-down of backlight
Ground	Ground for LCD Backlight assembly

Connector J28 provides the backlight power and control for the optional LCD panel. See the description for connector J24, above, for details on the LCD data interface.

> **Note:** The +12V supply will be removed when the system is powered down. The control signal is used to allow the system to power-down the backlight when the system enables monitor-power-down during its power management control. A 12V power supply must be provided either on the J11 input power connector, or on the 12V pin on the PC/104 connector for the LCD backlight to operate. This voltage is not generated internally.

5.18   CD Input (J30)

The J30 connector is for a PC-standard CD input cable, which provides the CD Audio Input to the AC97 Sound circuitry.

J30 CD Input Connector

PIN 1 → [••••]

1	Left CD input
2	Left ground
3	Right ground
4	Right CD input

The connector is an industry-standard CD-IN connector, which is common in most desktop Personal Computers. Note that the left and right grounds are decoupled but are also tied together on-board. This input is intended for CD-input only; i.e., no amplified or microphone inputs.

6. BOARD CONFIGURATION

The Athena II board has the following jumper-selectable configuration options.

> **Note:** Connector J10 is not installed on the standard Athena II board.

Jumper Block	Configuration Functions
J10	System configuration jumper block.
J13	Data acquisition circuit configuration jumper block.
J18	RS-485 mode selection jumper block.

6.1 System Configuration (J10)

Jumper block J10 is used to configure IRQ levels, ATX power control and CMOS RAM.

J10 Jumper Block with Default Settings
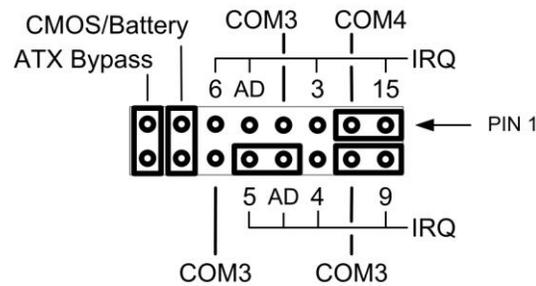
J10	
Pin Label	**Function**

BAT	Battery connected:
	  in - battery connected
	    (CMOS RAM settings preserved)
	  out - battery not connected
	    (CMOS RAM settings erased)

ATX	ATX power control
	  in - ATX-like power control
	  out - standard (powers up immediately)

3	IRQ 3; selectable for COM3, COM4
4	IRQ 4; selectable for COM3, ADC
5	IRQ 5; selectable for COM3, ADC
6	IRQ 6; selectable for COM3, ADC
9	IRQ 9; selectable for COM3
15	IRQ 15; selectable for COM4

6.1.1 Serial Port and A/D IRQ Settings

COM3, COM4 and A/D IRQ settings can be configured as shown in the following table.

Device	IRQ3	IRQ4	IRQ5	IRQ6	IRQ9	IRQ15
COM3	X	X	X	X	X (default)	-
COM4	X	-	-	-	-	X (default)
A/D	-	X	X (default)	X	-	-

Note: IRQ4 can only be used for A/D if it is not already used for COM3.

It is possible to set up all three circuits to share either IRQ4 or IRQ5. However, only one device can use the shared IRQ at a time; the ability for all three devices to run simultaneously is not supported.

Configure the IRQ options as shown in the following jumper settings.

IRQ Configuration Options

COM4: IRQ3
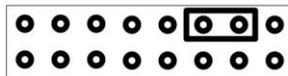
A/D: IRQ5 (default)
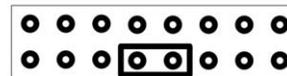
COM4: IRQ15 (default)
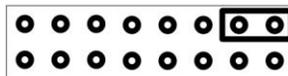
A/D: IRQ4

COM3: IRQ4

A/D: IRQ6
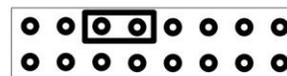
COM3: IRQ9 (default)
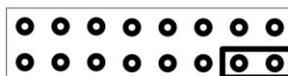
COM3, COM4, A/D: IRQ4

COM3, COM4: IRQ3
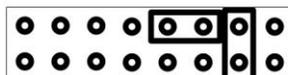
COM3, COM4, A/D: IRQ5

6.1.2   Erasing CMOS RAM Settings

With the jumper in place (enabled, as shown in Figure 3) the SBC powers up with the current settings, or if the jumper was removed before power up, the SBC will power up with the default BIOS settings.

CMOS RAM Jumper Settings

Battery Backup:
Enabled (default)
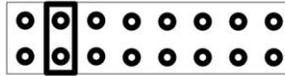
Follow these steps to clear the CMOS RAM.

1. Power-down the CPU.
2. Remove the BAT jumper.
3. Wait a few seconds.
4. Insert the BAT jumper.
5. Power-up the CPU.

    Note: Before erasing CMOS RAM, write down any custom BIOS settings.

6.1.3   ATX Power Control Settings

The ATX power control is set using the J10 ATX jumper, shown in Figure 4.

ATX Power Control Jumper Setting

ATX Bypass: Enabled (default)
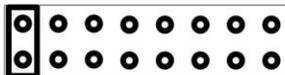
If the ATX jumper is out, ATX works normally, and an external, momentary switch may be used to turn power ON and OFF. A quick contact turns the power ON, and a long contact (greater than four seconds) turns the power OFF.

If the ATX jumper is in, the ATX function is bypassed and the system powers up as soon as power is connected. This is the default setting, as shown in Figure 4.

If the ATX jumper is removed, the battery-backup for CMOS does not function when power is removed.

6.2   DAC Configuration (J13)

Jumper block J13 is used to configure the A/D and D/A circuits

J13 Jumper Block

.
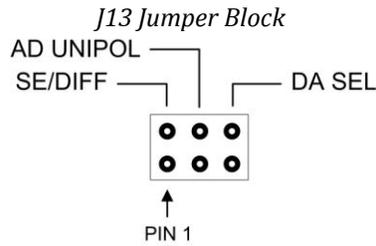
Jumper Label	Configuration Function
SE/DIFF	A/D single-ended/differential selection.
AD UNIPOL	A/D unipolar/bipolar selection.
DA SEL	D/A unipolar/bipolar selection.

6.2.1   Single-Ended/Differential Input Settings

Athena II can accept both single-ended and differential inputs. A single-ended input uses two wires: input and ground. The measured input voltage is the difference between these two wires. A differential input uses three wires: input(+), input(−) and ground. The measured input voltage is the difference between the (+) and (−) inputs.

Differential inputs are frequently used either when the grounds of the input device and the measurement device (Athena II) are at different voltages, or when a low-level signal is being measured that has its own ground wire. A differential input also has higher noise immunity than a single-ended input because most noise affects both (+) and (−) input wires equally, so the noise is canceled out in the measurement. The disadvantage of differential inputs is that only half as many are available because two input pins are required to produce a single differential input.

Athena II can be configured for either 16 single-ended inputs, or eight differential inputs, as shown below. The default setting is single-ended mode.

A/D Single-ended/Differential Selection
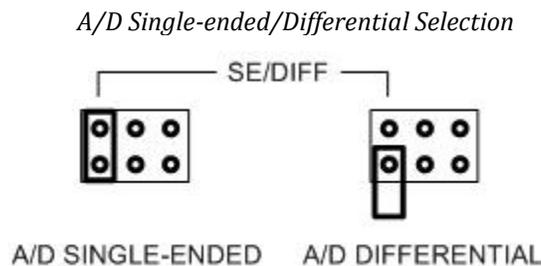
If you have a combination of single-ended and differential input signals, select differential mode. Then, to measure the single-ended signals, connect the signal to the plus (+) input and connect analog ground to the minus (−) input.

> WARNING: The maximum range of voltages that can be applied to an analog input on Athena II without damage is ±35V. If you connect the analog inputs on Athena to a circuit whose ground potential plus maximum signal voltage exceeds ±35V, the analog input circuit may be damaged. Check the ground difference between the input source and Athena II before connecting analog input signals.

6.2.2   Unipolar/Bipolar Input Settings

The analog inputs can be configured for either unipolar (positive input voltages only), or bipolar (both positive and negative input voltages). For unipolar inputs, install a jumper as shown below. For bipolar inputs, omit the jumper. The default configuration is bipolar mode (jumper out).

A/D Unipolar/Bipolar Selection
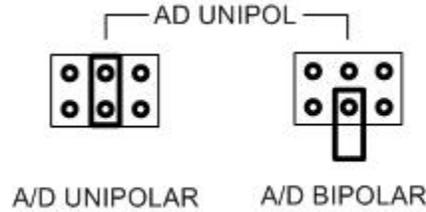
6.2.3   Analog Output Configuration Settings

The four analog outputs can also be configured for unipolar (positive voltages only) or bipolar (both positive and negative output voltages). In unipolar mode, the outputs range between 0-10V. In bipolar mode, the outputs range between ±10V. Install the jumper for unipolar mode, as shown below. The default configuration is bipolar mode (jumper out).

Analog Output Configuration Selection
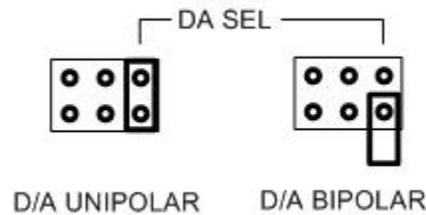
If the jumper is in, the outputs resets to the bottom of their range (zero-scale). If the jumper is out, the outputs resets to the middle of their range (mid-scale). Normally, the D/A is configured to power up to 0V. When the power is turned on, the device connected to the analog output does not see a step change in voltage. Therefore, for unipolar mode, the outputs should normally be configured for zero-scale reset, and for bipolar mode the outputs should be configured for mid-scale reset because 0V is halfway between -10V and +10V, for the ±10V range.

6.3   RS-485 Mode Selection (J18)

Jumper block J18 is used to select RS-485 mode for COM3/COM4.

J18 Jumper Block
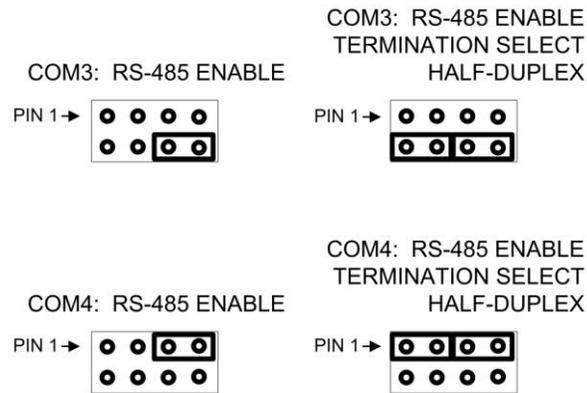
Note 1: RS-485 mode needs to be set in the BIOS.

Note 2: Echo is enabled when RS-485 is set in half-duplex mode.

7. SYSTEM OPERATION

7.1 System Resources

The table below lists the system resources utilized by the circuits on Athena II.

Device	Default Address	ISA IRQ	ISA DMA	Selectable Addresses
Serial Port COM1	I/O 0x3F8 – 0x3FF	3.4	–	2F8, 3E8, 2E8
Serial Port COM2	I/O 0x2F8 – 0x2FF	3,4	–	3F8, 3E8, 2E8
Serial Port COM3	I/O 0x3E8 – 0x3EF	3,4,5,6,9	–	–
Serial Port COM4	I/O 0x2E8 – 0x2EF	3,15	–	–
LPT Printer Port	I/O 0x378 – 0x37F	5,7	3	278, 3BC
IDE Controller A	I/O 0x1F0 – 0x1F7	14	–	–
A/D Circuit (when applicable)	I/O 0x280 – 0x28F	4,5,6	–	–
Watchdog Timer/Serial Port/FPGA	I/O 0x25C-0x25F	–	–	–
Ethernet	OS-dependent	OS-dependent	–	–
USB	OS-dependent	OS-dependent	–	–
Sound	OS-dependent	OS-dependent	–	–
Video	OS-dependent	OS-dependent	–	–

Note: In the preceding table, the selectable addresses are declared in CMOS BIOS.

Most of these resources are configurable and, in many cases, the Operating System alters these settings. The main devices that are subject to this dynamic configuration are on-board Ethernet, sound, video, USB, and any PC/104-*Plus* cards that are in the system. These settings may also vary depending on what other devices are present in the system. For example, adding a PC/104-*Plus* card may change the on-board Ethernet resources.

The serial port settings for COM3 and COM4 are jumper-selectable (J10), whereas the settings for COM1 and COM2 are entirely software-configured in the BIOS.

7.2 Console Redirection to a Serial Port

In many applications without a local display and keyboard, it may be necessary to obtain keyboard and monitor access to the CPU for configuration, file transfer, or other operations. Athena II supports this operation by enabling keyboard input and character output onto a serial port, referred to as console redirection. A serial port on another PC can be connected to the serial port on Athena II with a null modem cable, and a terminal emulation program, such as HyperTerminal, can be used to establish the connection. The terminal program must be capable of transmitting special characters including F2 (some programs or configurations trap special characters).

The default Athena II BIOS setting disables console redirection.

There are three possible configurations for console redirection:
- POST-only (default)
- Always On
- Disabled

To modify the console redirection settings:

1. Enter the BIOS.
2. Select the Advanced menu.
3. Select Console Redirection.
4. In Com Port Address, select Disabled to disable the function, On-board COM A for COM1, or On-board COM B for COM2 (default).

If you select Disabled, you will not be able to enter BIOS again during power-up through the serial port.

To reenter BIOS when console redirection is disabled, you must install a video monitor or LCD and use a keyboard. Erasing the CMOS RAM returns the BIOS to its default settings. CMOS RAM may be erased by removing the jumper on the JP10 jumper block.

> **Note:** Before erasing CMOS RAM, write down any custom BIOS settings you have made.

If you selected COMA or COMB, continue with the configuration, as follows.

1. For Console Type, select PC ANSI.
2. You can modify the baud rate and flow control here if desired.
3. At the bottom, for Continue C.R. after POST, select Off (default) to turn off after POST or select On to remain on always.
4. Exit the BIOS and save your settings.

7.3   Watchdog Timer

Athena II contains a watchdog timer circuit consisting of two programmable timers, WD1 and WD2, cascaded together. The input to the circuit is WDI and the output is WDO. WDI may be triggered in hardware or in software. A special "early" version of WDO may be output on the WDO pin. When this signal is connected to WDI, the watchdog circuit is re-triggered automatically. The watchdog timer block diagram is shown below.

Watchdog Timer Block Diagram
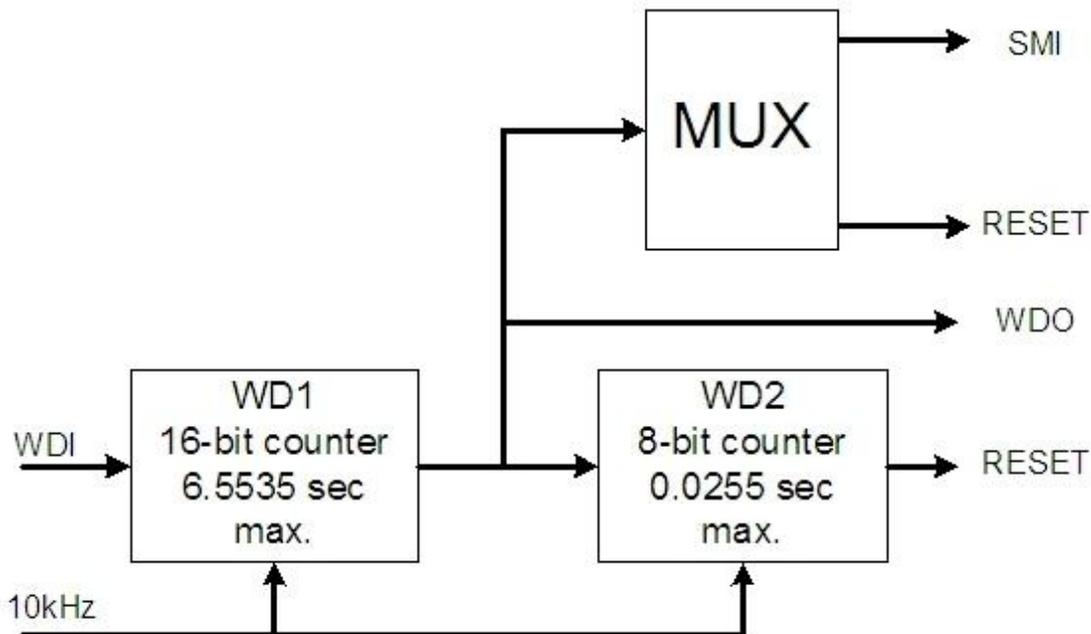
The duration of each timer is user-programmable. When WD1 is triggered, it begins to count down. When it reaches zero, it triggers WD2, sets WDO high, and may also generate a user-selectable combination of the following events.

- System Management interrupt (SMI)
- Hardware reset

WD2 then begins to count down. When the WD2 counter reaches zero, it unconditionally causes a hardware reset. The WD2 timer gives external circuits time to respond to the WDO event before the hardware reset occurs.

The watchdog timer circuit is programmed via I/O registers located on Page 0: Base +28-31. The Athena II watchdog timer is supported in the Diamond Systems Universal Driver software version 5.7 and later.

7.4   Flash Memory

Athena II contains a 512KB, 16-bit wide flash memory chip for storage of BIOS and other system configuration data.

7.5   Backup Battery

Athena II contains an integrated RTC/CMOS RAM backup battery. This battery has a capacity of 120mAH and will last over three years in power-off state.

The on-board battery is activated for the first time during initial factory configuration and test. Storage temperature of the board can affect the total battery life. Storage at 23ºC is recommended.

7.6   System Reset

Athena II contains a chip to control system reset operation. Reset occurs under the following conditions.

- User causes reset with a ground contact on the *Reset* input
- Input voltage drops below 4.75V
- Over-current condition on output power line

The ISA Reset signal is an active high pulse with a 200ms duration. The PCI Reset is active low, with a typical pulse width duration of 200 msec.

7.7   On-Board Video

Using the on-board VIA Mark processor, Athena II integrates all of the support needed for modern media. Refer to the VIA Technologies, Inc. documentation for the Mark processor, listed in the Additional Information section of this document.

8. BIOS

Athena uses a BIOS from Phoenix Technologies modified to support the custom features of the Athena board.

(See the detailed BIOS settings in Chapter 28, BIOS CMOS Option Listing.)

8.1 BIOS Settings

To change the following BIOS settings, press F2 during system startup power on self-test (POST).

8.1.1 Serial Ports

The address and interrupt settings for serial ports COM1 and COM2 may be modified. COM1 and COM2 address and interrupt settings are configured using the Advanced, Advanced Chipset Control, I/O Chip Device Configuration menu.

The addresses of COM3 and COM4 are fixed. The IRQ selections for COM3 and COM4 are configured using jumper block J10.

8.1.2 Parallel Port

The parallel port is configured using the Advanced, I/O Chip Device Configuration menu. The port is set by default to ECP mode and located at address 0x378, IRQ 7 and DMA 3.

8.1.3 LCD Video Settings

Athena provides direct digital support for LVDS-based LCD interfaces only. As such, there are two settings that affect this support during BIOS boot.

Boot Video Device – By default, this is set to "AUTO". With the AUTO setting, the system attempts to identify an RGB monitor (via DDC). If no RGB monitor is detected, the system enables LCD support. If you choose to use the LCD display regardless of standard monitor connection (i.e., with both connected at once), set "Boot Video Device" to "Both".

Panel Type – This setting defaults to "7". Do not alter this setting unless specifically instructed to do so. This setting affects the LCD display modes supported; mode "7" is the only setting currently supported. Not all LCD displays are supported.

8.1.4 Miscellaneous Settings

- Memory Cache

  Unless there is a specific reason to change these settings, it is best to keep these settings as-is. Certain system functions, such as USB keyboard support under BIOS menus, may be adversely affected by changes to these settings. These cache settings can make a noticeable difference for low-level BIOS calls and, as such, can severely limit performance if they are disabled.

- Advanced Chipset Control

  The following settings should be retained:

    Frame Buffer Size: 8MB

    AGP Rate: 4X

    Expansion Bus Performance: Normal

The Frame Buffer size can be increased for specific applications. Be aware, however, that an increase in this memory size will result in a decrease in overall system memory available. The AGP rate affects internal video accesses and does not affect any external bus speeds.

"Expansion Bus Performance" is an adjustment to allow an increase in ISA I/O Access speeds. For applications where ISA I/O accesses seem to be a limiting factor, this performance may be increased to "Accelerated". Be aware that increasing these timings may adversely affect system stability with external add-on PC/104 cards. This setting has no direct affect on PCI or memory speeds; it only affects ISA PC/104 devices. It is best to leave this setting at "Normal," if there are no ISA I/O performance issues.

- Advanced

  Installed O/S: (See Appendix A, BIOS Settings) Select the operating system.

  Large Disk Access Mode: (See Appendix A, BIOS Settings) Select the disk access mode.

- On-Chip Multifunction Device

  USB Device: Enabled/disable USB ports.

  Legacy Audio:

  "Legacy Audio" only affects DOS-based applications when used with the VIA-supported DOS Drivers. Enabling this setting will require system I/O, IRQ, and DMA resources. It is strongly recommended that this setting be left "Disabled."

- PCI and ISA Configuration (from the Advanced menu)

  The following settings should be retained:

  PCI IRQ Level 1-4:   Auto-select for all

  PCI/PNP ISA UMB Region Exclusion: Available for all

- Power Management

  This setting is only effective under DOS. Otherwise, the OS power management settings pre-empt these settings. The only power management mode supported by the system is "Power-On Suspend." Other suspend modes are not supported and should not be used under any OS. Examples of unsupported suspend modes include, "Hibernate," under Windows, and "Suspend-to-Disk" or "Suspend-to-RAM".

- Memory Shadow

  These parameters should only be modified by advanced users. These settings can adversely affect system performance and reliability.

8.2   BIOS Console Redirection Settings

For applications where the Video interfaces are not used, the textual feedback typically sent to the monitor can be redirected to a COM port. In this manner, a system can be managed and booted without using a video connection.

The BIOS allows the following configuration options for Console Redirection to a COM port.

- COM port address: Disabled (default), COM port A, or COM port B.

  If Console Redirection is enabled here, the associated COM port (with "A" here referring to COM 1 and "B" referring to COM 2) is enabled regardless of the COM port settings elsewhere.

- "Continue CR after POST": Off (default), or On.

- Determines whether or not the system is to wait for a carriage return over the COM port before continuing (after POST is completed and before OS starts loading).

- Baud Rate: 19.2K (default), 300, 1200, 2400, 9600, 38.4K, 57.6K, 115.2K.

- Console Connection: Direct (default) or Modem.

- Console Type: PC ANSI (default), VT100, VT100 (8-bit), PC-ANSI (7-bit), VT100+, or VT-UTF8.

- Flow Control: CTS/RTS (default), XON-XOFF, None.

- Number of video Pages to support: 1(default) to 8.

  Note: Console Redirection only works for text-based interaction. If the OS enables video and starts using direct video functions (which would be the case with a Linux X-terminal or Windows, for example), Console Redirection has no effect and video is then required.

9. SYSTEM I/O

9.1   Ethernet

The Ethernet chip is the National Semiconductor DP83815 MacPhyter chip, which is connected to the system via the board's internal PCI bus.

The Athena II Software CD includes Ethernet drivers for Windows XP, Windows CE, and Linux. The latest drivers can also be downloaded from National Semiconductor's website, listed in the Additional Information section of this document. (Search for "DP83815" to locate the product folder on the website).

A DOS utility program is provided for testing the chip and accessing the configuration EEPROM. Each board is factory-configured for a unique MAC address using this program. To run the program, boot the computer to DOS because the program will not run properly in a DOS window. In normal operation this program is not required.

Additional software support includes a packet driver with software to allow a full TCP/IP implementation.

9.2   Serial Ports

Athena II contains four serial ports. Each port is capable of transmitting at speeds up to 115.2Kbaud. Ports COM1 and COM2 are built into the standard chipset, which are standard 16550 UARTs with 16-byte FIFOs.

Ports COM3 and COM4 are derived from an Exar 16C2850 dual UART chip and include 128-byte FIFOs. These ports may be operated at speeds to 1.5Mbaud with installation of high-speed drivers, as a custom option.

The serial ports use the following default system resources.

Port	I/O Address Range	IRQ
COM1	0x3F8 - 0x3FF	4
COM2	0x2F8 - 0x2FF	3
COM3	0x3E8 - 0x3EF	3,4,5,6,9
COM4	0x2E8 - 0x2EF	3,15

The COM1 and COM2 settings may be changed in the system BIOS. Select the *Advanced* menu, followed by *I/O Device Configuration,* to modify the base address and interrupt level.

The addresses of COM3 and COM4 are fixed. The IRQ settings for COM3 and COM4 are selected using jumper block J10. COM3 can use IRQ3, IRQ4, IRQ5, IRQ6 or IRQ9, and COM4 can use IRQ3 or IRQ15, as described in the Board Configuration section of this document.

> **Note:** Once these jumper selections are made, the user must update the Serial Port IRQ settings to match these selections. The IRQ settings are NOT auto detected in the same way as the address settings.

9.3   PS/2 Ports

Athena II supports two PS/2 ports.
- Keyboard
- Mouse

The PS/2 ports are accessible using a cable assembly (DSC#C-PRZ-01) attached to connector J3. Support for these ports is independent of, and in addition to, mouse and keyboard support using the USB ports.

9.4   USB Ports

Four USB 1.1 ports, USB0 through USB3, are accessible using cable assemblies attached to connector J5.

USB support is intended primarily for the following devices (although any USB-standard device should function).

- Keyboard
- Mouse
- USB Floppy Drive (This is required for Crisis Recovery of boot ROM)
- USB flash disk

The BIOS supports the USB keyboard during BIOS initialization screens and legacy emulation for DOS-based applications.

The USB ports can be used for keyboard and mouse at the same time that the PS/2 keyboard and mouse are connected.

10. NOTES ON OPERATING SYSTEMS AND BOOTING PROCEDURES

10.1 Windows Operating System Installation Issues

Windows operating systems installation should follow these steps, or some device drivers may not function correctly under Windows.

1. Enable CD-ROM support in the BIOS. Change the boot sequence in the BIOS so the system boots from CD-ROM first.
2. Insert the Windows installation CD into the CD-ROM and restart the computer.
3. Follow the manufacturer's instructions for installing Windows.

10.1.1 Driver Installation

Drivers are provided on a CD. Please, follow the instructions included on the CD to install drivers for the different operating systems.

10.1.2 BIOS Setting for Windows

When using any version of Windows, the Operating System selection in the BIOS setup menus should be set to Win98. Also, *Legacy Audio* must be disabled for Windows to boot properly.

10.1.3 CompactFlash Under Windows

CompactFlash is not directly supported by Windows 98. A special driver may be available (see the vendor of your specific CompactFlash card for details). Without special drivers, Windows 98 does not recognize the CompactFlash.

CompactFlash support is built into Windows 2000 and XP.

10.2 DOS Operating Systems Installation Issues

User the following sequence to install DOS operating systems: MS-DOS, FreeDOS and ROM-DOS.

1. Enable the following in BIOS:
   o Floppy Drive detection
   o Legacy USB support
2. Change the BIOS boot sequence so the system boots through the USB floppy drive.
3. Insert the DOS installation floppy disk into the USB floppy drive and start/restart the system.
4. Install any drivers needed.

   Note: For DOS Ethernet, set **Operating System** to **other** in the BIOS.

   Note: DOS Sound emulation is currently not functional.

10.3 CompactFlash Compatibility Issues Under DOS

CompactFlash is incompatible with some utilities, under some versions of DOS.

- CompactFlash with ROM-DOS

  The ROM-DOS FDISK utility does not work with CompactFlash drives. The ROM-DOS FORMAT and SYS do work, however. If CompactFlash already has a DOS partition, the ROM-DOS utilities can be used to FORMAT the CompactFlash and install operating system files on CompactFlash.

- CompactFlash with FreeDOS

  The FreeDOS FDISK or FORMAT utility do not work with CompactFlash. However, the FreeDOS SYS utility is functional with CompactFlash.

- CompactFlash with MS-DOS

  The MS-DOS FDISK, FORMAT, and SYS utilities are not functional when used with CompactFlash. The MS-DOS operating system files cannot be installed on CompactFlash flash.

11. DATA ACQUISITION CIRCUIT

Athena II contains a data acquisition subsystem consisting of A/D, D/A, digital I/O, and counter/timer features. This subsystem is equivalent to a complete add-on data acquisition module.

The A/D section includes a 16-bit A/D converter, 16 input channels, and a 2048-sample FIFO. Input ranges are programmable, and the maximum sampling rate is 100KHz. The D/A section includes 4 12-bit D/A channels. The digital I/O section includes 24 lines with programmable direction. The counter/timer section includes a 24-bit counter/timer to control A/D sampling rates and a 16-bit counter/timer for user applications.

High-speed A/D sampling is supported with interrupts and a FIFO. The FIFO is used to store a user-selected number of samples, and the interrupt occurs when the FIFO reaches this threshold. Once the interrupt occurs, an interrupt routine runs and reads the data out of the FIFO. In this way the interrupt rate is reduced by a factor equal to the size of the FIFO threshold, enabling a faster A/D sampling rate. The circuit can operate at sampling rates of up to 100KHz, with an interrupt rate of 6.6-10KHz.

The A/D circuit uses the default (hard wired) setting of I/O base address 280h and IRQ 5. The IRQ setting can be changed if needed. The interrupt level is changed with jumper block J10 and also with the IRQ number in the BIOS.

The figure below shows a block diagram of the data acquisition circuit.

ATHENA II DATA ACQUISITION BLOCK DIAGRAM
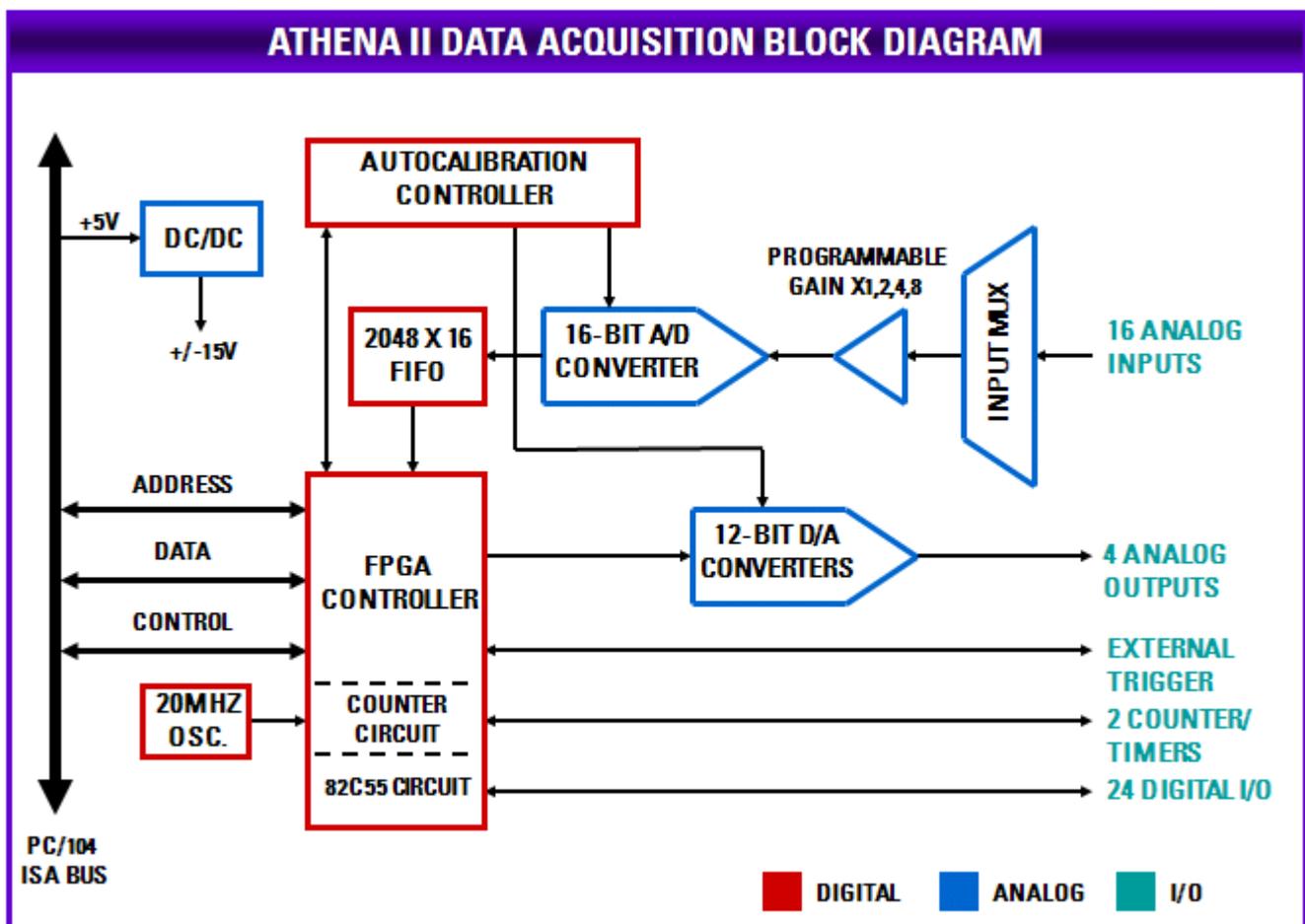
11.1 Data Acquisition Circuitry I/O Map

11.1.1 Overview

The data acquisition circuitry on Athena II occupies 16 bytes in I/O memory space. The default address range is 280h (base address) to 28Fh.

The data acquisition FPGA can be enabled/disabled in the BIOS under the Advanced menu. Scroll down to the "FPGA Mode" option and select "Enabled" or "Disabled," accordingly. If the FPGA is disabled you will not be able to interact with the data acquisition circuit. The FPGA can also be enabled or disabled programmatically through the CPLD.

11.1.2 Register Map Page Summary

The following table summarizes the DAC register functions. The registers are paged to allow access to enhanced functions. There are three register pages and the desired page is selected using the A/D gain and scan settings register, Base+3, bits PG0-PG1, provided the board is in enhanced mode.

Page 0		
Base +	Write Function	Read Function
0	Command	A/D LSB
1	Enhanced mode control	A/D MSB
2	A/D channel	A/D channel
3	A/D gain/page select/scan settings	A/D gain and status
4	Interrupt/DMA/counter control	Interrupt/DMA/counter control
5	FIFO threshold	FIFO threshold
6	DAC LSB	FIFO depth
7	DAC MSB + channel no.	Analog operation status
8	Digital I/O port A	Digital I/O port A
9	Digital I/O port B	Digital I/O port B
10	Digital I/O port C	Digital I/O port C
11	Digital I/O control	Digital I/O control
12	Counter/timer D7-0	Counter/timer D7-0
13	Counter/timer D15-8	Counter/timer D15-8
14	Counter/timer D23-16	Counter/timer D23-16
15	Counter/timer control	FPGA revision code

Page 1		
Base +	Write Function	Read Function
12	Trim DAC data/EEM data	EEM data
13	EEPROM command/Trim DAC	EEM command address
14	Auto-CAL/Trim DAC	Trim DAC/EEM/Auto-Cal status
15	Write enable	Page 1 select read back check

Page 2		
Base +	Write Function	Read Function
12	ADC expanded FIFO	ADC expanded FIFO
13	ADC control	ADC control
14	-	-
15	-	Page 2 select read back check

Note 1: Page 0, registers 0-11 are accessible when Page 1 or Page 2 are selected.

Note 2: In the following tables, blank bits are not used. Writes to a blank bit have no effect and reads from a blank bit return a value of zero.

11.1.3 Register Map Bit Summary

Page 0 Write Register Summary

Base +	7	6	5	4	3	2	1	0
0	STRTAD	RSTBRD	RSTDA	RSTFIFO	CLRDMA	CLRT	CLRD	CLRA
1	EM7	EM6	EM5	EM4	EM3	EM2	EM1	EM0
2	H3	H2	H1	H0	L3	L2	L1	L0
3	-	-	-	-	-	SCANEN	G1	G0
4	CKSEL1	CKFRQ1	CKFRQ0	ADCLK	DMAEN	TINTE	DINTE	AINTE
5	FT7	FT6	FT5	FT4	FT3	FT2	FT1	FT0
6	DA7-DA0							
7	DACH1	DACH0	-	-	DA11	DA10	DA9	DA8
8	A7	A6	A5	A4	A3	A2	A1	A0
9	B7	B6	B5	B4	B3	B2	B1	B0
10	C7	C6	C5	C4	C3	C2	C1	C0
11	DIOCTR	-	-	DIRA	DIRCH	-	DIRB	DIRCL
12	D7	D6	D5	D4	D3	D2	D1	D0
13	D15	D14	D13	D12	D11	D10	D9	D8
14	D23	D22	D21	D20	D19	D18	D17	D16
15	CTRNO	LATCH	GTDIS	GTEN	CTDIS	CTEN	LOAD	CLR

Page 0 Read Register Summary

Base +	7	6	5	4	3	2	1	0
0	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0
1	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8
2	H3	H2	H1	H0	L3	L2	L1	L0
3	STS	SD	WAIT	DACBSY	OVF	SCANEN	G1	G0
4	CKSEL1	CKFRQ1	CKFRQ0	ADCLK	DMAEN	TINTE	DINTE	AINTE
5	FT7	FT6	FT5	FT4	FT3	FT2	FT1	FT0
6	FD7	FD6	FD5	FD4	FD3	FD2	FD1	FD0
7	DMAINT	TINT	DINT	AINT	ADCH3	ADCH2	ADCH1	ADCH0
8	A7	A6	A5	A4	A3	A2	A1	A0
9	B7	B6	B5	B4	B3	B2	B1	B0
10	C7	C6	C5	C4	C3	C2	C1	C0
11	DIOCTR	-	-	DIRA	DIRCH	-	DIRB	DIRCL
12	D7	D6	D5	D4	D3	D2	D1	D0
13	D15	D14	D13	D12	D11	D10	D9	D8
14	D23	D22	D21	D20	D19	D18	D17	D16
15	REV7	REV6	REV5	REV4	REV3	REV2	REV1	REV0

Page 1 Write Register Summary

Base +	7	6	5	4	3	2	1	0
12	TDAD7-TDAD0 – or - EMM_CD7-EMM_CD0							
13	EEM_CA7	EEM_CA6	EEM_CA5	EEM_CA4	EEM_CA3	EEM_CA2	EEM_CA1	EEM_CA0
13	-	-	-	-	-	TDAA2	TDAA1	TDAA0
14	EEMST		0	ADCMEN	TDAST	0	0	0
15	WREN7-WREN0							

Page 1 Read Register Summary

Base +	7	6	5	4	3	2	1	0
12	EEM_D7-EEM_D0							
13	EEM_CA7-EEM_CA0							
14	0	TDABSY	EEMBSY	ADCMEN	-	-	-	-
15	PG1ID							

11.1.4
Page 2 Write Register Summary

Base +	7	6	5	4	3	2	1	0
12	-	-	-	-	-	-	-	ADCEXF
13	0	0	0	0	UNIBIDI	UNIBIOE	SEDIFDI	SEDIFOE
14	-	-	-	-	-	-	-	-
15	-	-	-	-	-	-	-	-

Page 2 Read Register Summary

Base +	7	6	5	4	3	2	1	0
12	0	0	0	ADC_FOF	ADC_FF	ADC_FTF	ADC_FE	ADCEXF
13	0	0	0	0	UNIBIDI	UNIBIOE	SEDIFDI	SEDIFOE
14	-	-	-	-	-	-	-	-
15	PG2ID							

ADF_FOF   A/D Converter FIFO overflow. If this bit is set a FIFO overflow has occurred. No new values are written to the FIFO until this condition is corrected.

ADC_FF   A/D Converter FIFO Full. If this bit is set the FIFO is full.

ADC-FTF   A/D Converter FIFO Threshold Full. If this bit is set the FIFO depth has reached or exceeded the threshold.

ADC_FE   A/D Converter FIFO EMPTY. If this bit is set the FIFO is empty.

11.2 Page 0 Register Definitions

Command: Base+0 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	STRTAD	RSTBRD	RSTDA	RSTFIFO	CLRDMA	CLRT	CLRD	CLRA

STRTAD   Start an A/D conversion (trigger the A/D) when in software-trigger mode AINTE = 0 (Base+4, bit 0). Once the program writes to this bit, the A/D conversion starts and the STS bit (base+3, bit 7) goes high. The program should then monitor STS and wait for it to go low (the value of Base+3 is less than 128 or 0x80). When STS goes, low the A/D data at Base+0 and Base+1 may be read.

   When AINTE = 1 (Base+4, bit 0), the A/D cannot be triggered by writing to this bit. Instead, the A/D is triggered by a signal selected by ADCLK (Base+4 bit 5).

RSTBRD   Reset the entire board excluding the D/A. Writing a 1 to this bit causes all on-board registers to be reset to 0. The effect on the digital I/O is that all ports are reset to input mode, and the logic state of their pins is determined by the pull-up/pull-down configuration setting selected by the user. All A/D, counter/timer, interrupt and DMA functions cease. However, the D/A values remain constant.

RSTDA   Reset the four analog outputs. The analog outputs are reset to either mid-scale or zero-scale, depending on the jumper configuration selected by the user. A separate reset is provided for the D/A so that the user may reset the board if needed without affecting the circuitry connected to the analog outputs.

RSTFIFO   Reset the FIFO depth to 0. This clears the FIFO, allowing additional A/D conversions to be stored in the FIFO starting at address 0.

CLRDMA   Writing a 1 to this bit resets the DMA interrupt request flip flop.

CLRT   Writing a 1 to this bit resets the timer interrupt request flip flop.

CLRD   Writing a 1 to this bit resets the digital I/O interrupt request flip flop.

CLRA   Writing a 1 to this bit resets the analog interrupt request flip flop.

- This register performs various functions. The register bits are not data bits but, instead, command triggers. Each function is initiated by writing a 1 to a particular bit. Writing a 1 to any bit in this register does not affect any other bit in this register. For example, to reset the FIFO, write the value 0x10 (16) to this register to write a 1 to bit 4. No other function of the register will be performed. Multiple actions can be performed, simultaneously, by writing a 1 to multiple bits, using a single write operation.

- The user's interrupt routine must write to the appropriate bit prior to exiting to reset the interrupt request flip flop, enabling future interrupts. Otherwise, the interrupt line remains high, indefinitely, and no additional interrupt requests are generated by the board.

A/D LSB: Base+0 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0

AD7-AD0   A/D LSB data. The A/D data must be read LSB first, followed by MSB.

The A/D value is derived by reading two bytes from Base + 0 and Base + 1 and applying the following formula:

A/D value = (Base+0 value) + ((Base+1 value) * 256)

The value is interpreted as a two's complement, 16-bit number ranging from –32768 to +32767. This raw A/D value is converted to the corresponding input voltage and/or the engineering units represented by that voltage by applying additional application-specific formulas. Both conversions (conversion to volts and conversion to engineering units) may be combined into a single formula for efficiency.

A/D MSB: Base+1 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8

AD15-AD8 A/D MSB data. The A/D data must be read LSB first, followed by MSB.

(Refer to the method for deriving the A/D value described in the Base+0 (Read) description, above.)

Enhanced Mode Control: Base+1 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	EM7	EM6	EM5	EM4	EM3	EM2	EM1	EM0

EM0-EM7   Enhanced mode control:

0xA5 = Enable enhanced mode.

0xA6 = Disable enhanced mode (default state).

A/D Channel: Base+2 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	H3	H2	H1	H0	L3	L2	L1	L0

H3-H0   High channel of A/D channel scan range.

Ranges from 0 to 15 in single-ended mode, 0 to 7 in differential mode.

L3-L0   Low channel of A/D channel scan range.

Ranges from 0 to 15 in single-ended mode, 0 to 7 in differential mode.

- The high channel must be greater than or equal to the low channel.

- When this register is written, the current A/D channel is set to the low channel, so that the next time an A/D conversion is triggered the low channel will be sampled.

- When this register is written, the WAIT bit (Base+3, bit 5) goes high for 10 microseconds to indicate that the analog input circuit is settling. During this time, an A/D conversion should not be performed because the data will be inaccurate.

- After writing a new gain setting (Base+3), the WAIT bit is also set, and the program must monitor the bit prior to starting an A/D conversion.

- The channel and gain registers can be written to in succession without waiting for the intervening WAIT signal. Only one WAIT period must be observed between the last triggering condition (write to Base+2 or Base+3) and the start of an A/D conversion.

- The A/D circuit is designed to automatically increment the A/D channel each time a conversion is generated. This allows the user to avoid needing to write to the A/D channel each time. The A/D channel rotates through the values between LOW and HIGH. For example, if LOW = 0 and HIGH = 3, the A/D channels progresses through the following sequence: 0, 1, 2, 3, 0, 1, 2, 3, 0, 1, ….

- Reading from this register returns the value previously written to it.

Analog Input Gain/Page Select/Scan Settings: Base+3 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	-	-	PG1	PG0	-	SCANEN	G1	G0

PG1-PG0   Page select (Page 0 - Page 2)

- Standard Mode:

    00 = Page 0

    01 = Page 1

    10 = Page 2

- Reset and Enhanced Mode:

    00 = Page 0

    01 = Page 0

    10 = Page 0

    Note: When the board is in standard mode, only page 0 can be accessed. The page mode can only be set when the register map is in enhanced mode.

SCANEN   Scan mode enable.

    1 = Each A/D trigger causes the board to generate an A/D conversion on each channel in the range LOW – HIGH. The range is set with the channel register in Base+2.

    The STS bit (Base+3, bit 7) stays high during the entire scan.

    0 = Each A/D trigger causes the board to generate a single A/D conversion on the current channel. The internal channel pointer increments to the next channel in the range LOW – HIGH or resets to LOW, if the current channel is HIGH.

    The STS bit (Base+3, bit 7) stays high during the A/D conversion.

G1-G0   Analog input gain. The gain is the ratio of the voltage seen by the A/D converter and the voltage applied to the input pin. The gain setting is the same for all input channels.

- When this register is written, the WAIT bit (Read Base+3, bit 6) goes high for 10 microseconds to indicate that the analog input circuit is settling. During this time, an A/D conversion should not be performed because the data will be inaccurate. After writing a new gain setting, the program should monitor the WAIT bit prior to starting an A/D conversion.

- After writing a new channel selection (Base+2), the WAIT bit is also set, and the program must monitor it prior to starting an A/D conversion.

- The channel and gain registers can be written to in succession without waiting for the intervening WAIT signal. Only one WAIT period must be observed between the last triggering condition (write to Base+2 or Base+3) and the start of an A/D conversion.

- The following table lists the possible analog input ranges.

G1	G0	Gain	Unipolar Range	Bipolar Range
0	0	1	Invalid	±10V
0	1	2	0 - 10V	±5V
1	0	4	0 - 5 V	±2.5V
1	1	8	0 - 2.5V	±1.25V

Analog Input Status: Base+3 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	STS	SD	WAIT	DACBSY	OVF	SCANEN	G1	G0

STS A/D status.

   1 = A/D conversion or scan in progress.

   0 = A/D is idle.

   If SCANEN = 0, single conversion mode, STS goes high when an A/D conversion is started and stays high until the conversion is finished. If SCANEN = 1, scan mode enabled, STS stays high during the entire scan. After starting a conversion in software, the program must monitor STS and wait for the value to be 0 before reading A/D values from Base+0 and Base+1.

SD Single-ended/differential mode indicator.

   1 = Single-ended

   0 = Differential

WAIT A/D input circuit status.

   1 = A/D circuit is settling on a new value.

   0 = ok to start conversion.

   WAIT goes high after the channel register (Base+2) or the gain register (Base+3) changes, and remains high for nine microseconds. The program should monitor this bit after writing to either the channel or gain register, and wait for the value to become 0 prior to starting an A/D conversion.

DACBSY DAC is busy updating indicator (approx. 30 µS)

   1 = Busy

   0 = Idle

   Do not attempt to write to the DAC (Base+6 and Base+7) while the value of this bit is 1.

OVF FIFO Overflow bit. This bit indicates that the FIFO has overflowed, meaning that the A/D

circuit has attempted to write data to a full FIFO. This condition occurs when data is written into the FIFO faster than the FIFO is read.

When overflow occurs, the FIFO discards additional data until it is reset. The OVF condition is sticky, with the bit remaining set until the FIFO is reset, allowing the application program to determine if overflow has occurred. If overflow occurs, then you must either reduce the sample rate or increase the efficiency of your interrupt routine and/or operating system.

SCANEN   Scan mode readback. (See Base+3, write, above).

G1-G0   Gain. The gain is the ratio between the input voltage and the voltage seen by the A/D converter. The A/D always works with a maximum input voltage of 10V. A gain of two means the maximum input voltage at the connector pin is 5V.

   0 = gain of 1

   1 = gain of 2

   2 = gain of 4

   3 = gain of 8

   (See the description for register Base+3, write, above).

Interrupt/DMA/Counter Control: Base+4 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	CKSEL1	CKFRQ1	CKFRQ0	ADCLK	DMAEN	TINTE	DINTE	AINTE

CKSEL1   Clock source selection for counter/timer 1.

   0 = Internal oscillator, frequency selected by CLKFRQ1

   1 = External clock input CLK1 (DIO C pins must be set for ctr/timer signals)

CLFRQ1   Input frequency selection for counter/timer 1 when CKSEL1 = 1.

   0 = 10MHz

   1 = 100KHz

CKFRQ0   Input frequency selection for counter/timer 0.

   0 = 10MHz

   1 = 1MHz

ADCLK   A/D trigger select when AINTE = 1.

   0 = Internal clock output from counter/timer 0

   1 = External clock input EXTTRIG

DMAEN   Enable DMA operation.

   1 = Enable

   0 = Disable

TINTE   Enable timer interrupts.

   1 = Enable

   0 = Disable

DINTE   Enable digital I/O interrupts.

   1 = Enable

0 = Disable

AINTE   Enable analog input interrupts.

        1 = Enable

        0 = Disable

        NOTE: When AINTE = 1, the A/D cannot be triggered by writing to Base + 0.

- Analog output interrupts are not supported on this board.
- Multiple interrupt operations may be performed, simultaneously. All interrupts are at the same interrupt level. The user's interrupt routine must monitor the status bits to know which circuit has requested service. After processing the data but before exiting, the interrupt routine must clear the appropriate interrupt request bit, using the Base+0 register.

FIFO Threshold: Base+5 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	-	-	FT5	FT4	FT3	FT2	FT1	FT0

FT0-FT5   FIFO threshold. When the number of A/D samples in the FIFO reaches this number, the board generates an interrupt and sets AINT high (Base+7, bit 4). The interrupt routine is responsible for reading the correct number of samples out of the FIFO.

        The valid range is 1 to 48. A value of 48 is used, if a value greater than 48 is written to this register. A value of 1 is used, if 0 is written to this register. The interrupt rate is equal to the total sample rate divided by the FIFO threshold. Generally, for higher sampling rates a higher threshold should be used to reduce the interrupt rate. However, remember that the higher the FIFO threshold, the smaller the amount of FIFO space remaining to store data while waiting for the interrupt routine to respond. If a FIFO overflow condition occurs, lower the FIFO threshold and/or lower the A/D sampling rate.

DAC LSB: Base+6 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	DA7-DA0							

DA7-DA0   D/A LSB data.

        D/A data is an unsigned 12-bit value. This register must be written to before Base+7, because writing to Base+7 immediately updates the DAC.

A/D FIFO Depth: Base+6 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	FD7-FD0							

FD7-FD0   Current FIFO depth.

When in 48-sample FIFO mode, this value indicates the number of 16-bit A/D values currently stored in the FIFO. When in 2048-sample FIFO mode, this value represent the upper eight bits of an 11-bit value.

DAC MSB + Channel No.: Base+7 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	DACH1	DACH0	-	-	DA11	DA10	DA9	DA8

DACH0-1   D/A channel.

The values written to Base+6 and Base+7 are written to the selected channel, and that channel is immediately updated. The update takes approximately 20 microseconds because of the DAC serial interface.

DA8-DA11 D/A bits 8 to 11.

DA11 is the MSB. D/A data is an unsigned 12-bit value.

Analog Operation Status: Base+7 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	DMAINT	TINT	DINT	AINT	ADCH3	ADCH2	ADCH1	ADCH0

DMAINT   DMA interrupt status.

1 = interrupt pending

0 = interrupt not pending

TINT   Timer interrupt status.

1 = interrupt pending

0 = interrupt not pending

DINT   Digital I/O interrupt status

1 = interrupt pending

0 = interrupt not pending

AINT   Analog input interrupt status

1 = interrupt pending

0 = interrupt not pending

ADCH0-3   Current A/D channel. This is the channel sampled on the next conversion.

When any of bits 7–4 are 1, the corresponding circuit is requesting service. The interrupt routine must poll these bits to determine which circuit needs service and then act accordingly.

Digital I/O Port A: Base+8 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	A7	A6	A5	A4	A3	A2	A1	A0

A0-A7   Port A data. The register direction is controlled by bits in the register Base+11, below.

Digital I/O Port B: Base+9 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	B7	B6	B5	B4	B3	B2	B1	B0

B0-B7   Port B data. The register direction is controlled by bits in the register Base+11, below.

Digital I/O Port C: Base+10 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	C7	C6	C5	C4	C3	C2	C1	C0

C0-C7   Port C data. The register direction is controlled by bits in the register Base+11, below.

Digital I/O Control: Base+11 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	DIOCTR	-	-	DIRA	DIRCH	-	DIRB	DIRCL

DIOCTR   Selects counter I/O signals or digital I/O lines C4-C7, on pins 21-24 of J14. If DIOCTR = 0, the pin direction is as shown in the following table. If DIOCTR = 1, the pin direction is controlled by the DIRCH bit.

Pin No.	DIOCTR = 1	DIOCTR = 0	Pin direction, for DIOCTR = 0
21	C4	Gate0	Input
22	C5	Gate1	Input
23	C6	Clk1	Input
24	C7	Out0	Output

This bit resets to 1.

DIRA   Port A direction.

0 = output

1 = input

DIRCH   Port C, bits 7-4, direction.

0 = output

1 = input

DIRB   Port B direction.

0 = output

1 = input

DIRCL   Port C, bits 0-3, direction.

0 = output

1 = input

Counter/Timer Bits 0-7: Base+12 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	D7	D6	D5	D4	D3	D2	D1	D0

D0-D7   LSB for counter 0 and counter 1.

When writing to this register, an internal load register is loaded. Upon issuing a Load command, using Base+15, the selected counter's LSB register is loaded with this value.

When reading from this register, the LSB value of the most recent Latch command is returned.

Note: The value returned is NOT the value written to this register.

Counter/Timer Bits 8-15: Base+13 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	D15	D14	D13	D12	D11	D10	D9	D8

D8-D15   This register is the middle byte for counter 0 and the MSB byte for counter 1.

When writing to this register, an internal load register is loaded. Upon issuing a Load command, using Base+15, the selected counter's associated register is loaded with this value. For counter 0, the middle byte is loaded. For counter 1, the MSB byte is loaded.

When reading from this register, the associated byte of the most recent Latch command is returned.

Note: The value returned is NOT the value written to this register.

Counter/Timer Bits 16-23: Base+14 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	23	22	21	20	19	18	17	16

D16-D23   This register is used for 24-bit wide Counter 0, only.

When writing to this register, an internal load register is loaded. Upon issuing a Load command, using Base+15 for Counter 0, the counter's MSB register is loaded with this value. (When issuing a Load command for counter 1, this register is ignored).

When reading from this register, the MSB value of the most recent Latch command for counter 0 is returned.

Note: The value returned is NOT the value written to this register.

Counter/Timer Control: Base+15 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	CTRNO	LATCH	GTDIS	GTEN	CTDIS	CTEN	LOAD	CLR

CTRNO   Select counter number: 0 or 1.

LATCH   Latch the selected counter to read its value. T he counter must be latched before it is read. Reading from registers 12-14 returns the most recently latched value. If you are reading Counter 1 data, read only Base+12 and Base+13. Any data in Base+14 is from the previous Counter 0 access.

GTDIS   Disable external gating for the selected counter.

GTEN   Enable external gating for the selected counter. If enabled, the associated gate signal, GATE0 or GATE1, controls counting on the counter. If the GATEn signal is high, counting is enabled. If the GATEn signal is low, counting is disabled.

CTDIS   Disable counting on the selected counter. The counter ignores input pulses.

CTEN   Enable counting on the selected counter. The counter decrements with each input pulse.

LOAD   Load the selected counter with the data written to Base+12 through Base+14 or Base+12 and Base+13, depending on which counter is being loaded.

CLR   Clear the current counter, setting its value to 0.

This register is used to control the counter/timers. A counter is selected in bit 7 followed by a 1 written to any one of bits 6 – 0, to select the desired operation for that counter. The other bits and associated functions are not affected. Only one operation can be performed at a time.

FPGA Revision Code: Base+15 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	REV7	REV6	REV5	REV4	REV3	REV2	REV1	REV0

REV0-7   Revision code, read as a two-digit hexadecimal value. For example, a value of 0x20 is revision 2.0

11.3 Page 1 Register Definitions

Trim DAC data/EEM Data: Base+12 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	TDAD7-TDAD0 - or - EEM_CD7-EEM_CD0							

TDAD7- TDAD0	TrimDAC data to set the DAC output value to at the selected address. TrimDAC data can only be written when TDABSY (base+14) is not set. TrimDAC address can be written by writing to this register or through the EEM mode, (EEM-WriteTDA_Data). The reset value is zero.
EEM_CD7 - EEM_CD0	Data for the command data for the EEPROM. Data can only be written when EEMBSY (base+14) is cleared.

EEM Data: Base+12 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	EEM_D7-EEM_D0							

EEM_D7- EEM_D0	EEM data pointed to by EEPROM command address register (base+13).

EEPROM Command/Trim DAC Address: Base+13 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	EEM_CA7	EEM_CA6	EEM_CA5	EEM_CA4	EEM_CA3	EEM_CA2 /TDAA2	EEM_CA1 /TDAA1	EEM_CA0 /TDAA0

EEM_CA7 - EEM_CA0	EEPROM command address when EEPROM write enable. Can only write data when EEMBSY (base+14) is cleared.
TDAA2- TDAA0	TrimDAC address, 8x8 bytes.

        0: Q1, DAC1 ADCOFF range adjustment.

        1: Q2, DAC2 ADCOFF fine adjustment.

        2: Q3, DAC3 ADCFUL range adjustment.

        3: Q4, DAC4 ADCFUL fine adjustment.

        4: Q5, DAC5 DACOFF range adjustment.

        5: Q6, DAC6 DACOFF fine adjustment.

        6: Q7, DAC7 DACFUL range adjustment.

        7: Q8, DAC8 DACFUL fine adjustment.

        TrimDAC address can be written by writing to this register or through the EEM mode (). TrimDAC data can only be written when TDABSY (base+14) is not set.

        Reset value is zero.

EEM Command Address: Base+13 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	EEM_CA7-EEM_CA0							

EEM_CA7
-
EEM_CA0

EEPROM command address.

Auto-CAL/Trim DAC: Base+14 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	EEMST		0	ADCMEN	TDAST	0	0	0

EEMST   Sets the EEPROM read or write command. This flag is only executed when TDAST is set to zero.

0x10 = write command.

0x11 = read command.

ADCMEN   Multiplexer auto-calibrate mode.

Set to enable auto-calibrate mode.

TDAST   TDA start. Set to one to start the TrimDAC.

Note: Write to this register after TrimDAC data end address has been written.

Trim DAC/EEM/Auto-CAL Status: Base+14 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	0	TDABSY	EEMBSY	ADCMEN	-	-	-	-

TDABSY   TrimDAC busy flag.

1 = TrimDAC registers do not accept data, address or the start command.

EEMBSY   EEPROM busy flag.

1 = EEPROM busy.

ADCMEN   Multiplexer auto-calibrate mode.

1 = auto-calibrate enabled.

Write Enable: Base+15 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	WREN7-WREN0							

WREN7/0   EEPROM write enable.

Write the value 0xA5 before starting an EEPROM write command.

Note: This register can only be written when EEMBSY (base+14) is cleared.

Page 1 Select Read Back Check: Base+15 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	PG1ID							

PGID   Register page 1 ID. This register always contains the value 0xA1.

11.4   Page 2 Register Definitions

ADC Expanded FIFO: Base+12 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	-	-	-	-	-	-	-	ADCEXF

ADCEXF   ADC expanded FIFO mode flag.

0 = Not in expanded FIFO mode.

1 = In expanded FIFO mode.

Note: When in expanded FIFO mode, the FIFO threshold and FIFO depth bits represent the upper eight bits of an 11-bit value.

ADC Expanded FIFO: Base+12 (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	-	-	-	-	-	-	-	ADCEXF

ADCEXF   ADC expanded FIFO mode flag.

0 = Not in expanded FIFO mode.

1 = In expanded FIFO mode.

ADC Control: Base+13 (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	0	0	0	0	UNIBIDI	UNIBIOE	SEDIFDI	SEDIFOE

UNIBIDI   Controls unipolar/bipolar mode setting. When set, this overrides the jumper setting.

UNIBIOE   Output enable. When set, the UNIBIDI value is gated to the output.

SEDIFDI   Controls single-ended/differential mode setting. When set, this overrides the jumper setting.

SEDIFOE   Output enable. When set, the SEDIFDI value is gated to the output.

Page 2 Select Read Back Check: Base+15 (Read)

Bit:	7	6	5	4	3	2	1	0
Name:	PG2ID							

PGID   Register page 2 ID. This register always contains the value 0xA2.

12. ANALOG-TO-DIGITAL INPUT RANGES AND RESOLUTION

12.1 Overview

Athena II uses a 16-bit A/D converter. The full range of numerical values for a 16-bit number is 0 - 65535. However, the A/D converter uses two's complement notation, so the A/D value is interpreted as a signed integer, ranging from –32768 to +32767.

The smallest change in input voltage that can be detected is $1/(2^{16})$, or 1/65536, of the full-scale input range. This smallest change results in an increase or decrease of 1 in the A/D code, and is referred to as 1 LSB (1 Least Significant Bit).

The analog inputs on Athena II have three configuration options.

- Single-ended or differential mode
- Unipolar or bipolar mode
- Input range (gain)

The single-ended/differential and unipolar/bipolar modes are configured using jumper block J13, and apply to all inputs. The input range selection is done in software.

12.1.1 Input Range Selection

You can select a gain setting for the inputs, which causes them to be amplified before they reach the A/D converter. The gain setting is controlled in software, which allows it to be changed on a channel-by-channel basis. In general, you should select the highest gain (smallest input range) that allows the A/D converter to read the full range of voltages over which the input signals will vary. However, a gain that is too high causes the A/D converter to clip at either the high end or low end, and you will not be able to read the full range of voltages on your input signals.

12.1.2 Input Range Table

The table below indicates the analog input range for each possible configuration. The polarity is set using jumper block J13, and the gain is set with the G1 and G0 bits in the register at Base+3. The Gain value in the table is provided for clarity. Note that the single-ended vs. differential setting has no impact on the input range or the resolution.

Polarity	G1	G0	Input Range	Resolution 1LSB
Bipolar	0	0	±10V	305µV
Bipolar	0	1	±5V	153µV
Bipolar	1	0	±2.5V	76µV
Bipolar	1	1	±1.25V	38µV
Unipolar	0	0	Invalid	Invalid
Unipolar	0	1	0 - 10V	153µV
Unipolar	1	0	0 - 5V	76µV
Unipolar	1	1	0 - 2.5V	38µV

13. PERFORMING AN A/D CONVERSION

13.1 Introduction

This chapter describes the steps involved in performing an A/D conversion on a selected input channel using direct programming (without the driver software). Performing an A/D conversion according to the following steps. Each step is discussed in detail, below.

5. Select the input channel.
6. Select the input range.
7. Wait for analog input circuit to settle.
8. Initiate an A/D conversion.
9. Wait for the conversion to finish.
10. Read the data from the board.
11. Convert the numerical data to a meaningful value.

13.2 Select the Input Channel

To select the input channel to read, write a low-channel/high-channel pair to the channel register at Base+2. The low four bits select the low channel, and the high four bits select the high channel. When you write any value to this register, the current A/D channel is set to the low channel.

For example, to set the board to channel 4 only, write 0x44 to Base+2). To set the board to read channels 0 through 15, write 0xF0 to Base+2.

When you perform an A/D conversion, the current channel automatically increments to the next channel in the selected range. Therefore, to perform A/D conversions on a group of consecutively-numbered channels, you do not need to write the input channel prior to each conversion. For example, to read from channels 0 - 2, write 0x20 to base+2. The first conversion is on channel 0, the second will be on channel 1 and the third will be on channel 2. The channel counter wraps around to the beginning so the fourth conversion will be on channel 0, again.

If you are sampling the same channel repeatedly, set both high and low to the same value as in the first example, above. On subsequent conversions, you do not need to set the channel again.

13.3 Select the Input Range

Select the input range from among the available ranges. If the range is the same as for the previous A/D conversion it does not need to be set again. Write this value to the input range register at Base+3.

For example, for ±5V range (gain of 2), write 0x01 to Base+3.

13.4 Wait for Analog Input Circuit to Settle

After writing to either the channel register, Base+2, or the input range register, Base+3, allow time for the analog input circuit to settle before starting an A/D conversion. The board has a built-in 10μS timer to assist with the wait period. Monitor the WAIT bit at Base+3, bit 5. When the bit value is 1, the circuit is actively settling on the input signal. When the value is 0, the board is ready to perform A/D conversions.

13.5 Perform an A/D Conversion on the Current Channel

After the above steps are completed, start the A/D conversion by writing to Base+0. This write operation only triggers the A/D if AINTE = 0 (interrupts are disabled). When AINTE = 1, the A/D can only be triggered by the on-board counter/timer or an external signal. This protects against accidental triggering by software during a long-running interrupt-based acquisition process.

```
outp(base,0x80);
```

13.6 Wait for the Conversion to Finish

The A/D converter chip takes up to five microseconds to complete one A/D conversion. Most processors and software can operate fast enough so that if you try to read the A/D converter immediately after starting the conversion, the read will occur faster than the A/D conversion and return invalid data. Therefore, the A/D converter provides a status signal to indicate whether it is busy or idle. This bit can be read back from the status register at Base+3, bit 7. When the A/D converter is busy (performing an A/D conversion), the bit value is 1 and the program must wait. When the A/D converter is idle (conversion is done and data is available), this bit value is 0 and the program may read the data.

The following statement is a simple example of this operation.

```
while (inp(base+3) & 0x80);  // Wait for conversion to finish before proceeding
```

The above example could hang your program if there is a hardware fault and the bit is stuck at 1. A better solution is to use a loop with a timeout, as shown below.

```
int checkstatus()    // returns 0 if ok, -1 if error
int i;
for (i = 0; i < 10000; i++)
{
        if !(inp(base+3) & 0x80) then return(0);      // conversion completed
}
return(-1);                                          // conversion did not complete
```

13.7 Read the Data from the Board

Once the conversion is complete, you can read the data back from the A/D converter. The data is a 16-bit value and is read back in two 8-bit bytes. The LSB must be read from the board before the MSB because the data is inserted into the board's FIFO in that order. Unlike other registers on the board, the A/D data may only be read one time, because each time a byte is read from the FIFO the internal FIFO pointer advances and that byte is no longer available. Reading data from an empty FIFO returns unpredictable results.

The following pseudo-code illustrates how to read and construct the 16-bit A/D value.

```
LSB = inp(base);
MSB = inp(base+1);
Data = MSB * 256 + LSB;   // combine the 2 bytes into a 16-bit value
```

The final data are interpreted as a 16-bit signed integer in the range -32768 to +32767.

> **Note:** The data range always includes both positive and negative values, even if the board is set to a unipolar input range. The data must now be converted to volts or other engineering units by using a conversion formula, as discussed below.

In scan mode, the behavior is the same except when the program initiates a conversion, all channels in the programmed channel range will be sampled once and the data will be stored in the FIFO. The FIFO depth register increments by the scan size. When STS goes low, the program should read out the data for all channels.

13.8 Convert the numerical data to a meaningful value

Once the A/D value is read, it needs to be converted to a meaningful value. The first step is to convert it back to the actual measured voltage. Afterwards, you may need to convert the voltage to some other engineering units. For example, the voltage may come from a temperature sensor and the voltage would then need to be converted to the corresponding temperature, according to the temperature sensor's characteristics.

Since there are a large number of possible input devices, this secondary step is not included here. Only conversion to input voltage is described. However, you can combine both transformations into a single formula if desired.

To convert the A/D value to the corresponding input voltage, use the following formulas.

13.8.1 Conversion Formula for Bipolar Input Ranges

Input voltage = A/D value / 32768 * Full-scale input range

Example:

Given, Input range is ±5V and A/D value is 17761.

Therefore,

Input voltage = 17761 / 32768 * 5V = 2.710V.

For a bipolar input range,

1 LSB = 1/32768 * Full-scale voltage.

The table, below, shows the relationship between A/D code and input voltage for a bipolar input range (VFS = Full scale input voltage).

A/D Code	Input Voltage Symbolic Formula	Input Voltage for ±5V Range
-32768	$-V_{FS}$	-5.0000V
-32767	$-V_{FS} + 1$ LSB	-4.9998V
...	...	...
-1	-1 LSB	-0.00015V
0	0	0.0000V
1	+1 LSB	0.00015V
...	...	...
32767	$V_{FS} - 1$ LSB	4.9998V

13.8.2 Conversion Formula for Unipolar Input Ranges

Input voltage = (A/D value + 32768) / 65536 * Full-scale input range

Example:

Given, Input range is 0-5V and A/D value is 17761.

Therefore,

Input voltage = (17761 + 32768) / 65536 * 5V = 3.855V.

For a unipolar input range, 1 LSB = 1/65536 * Full-scale voltage.

The following table illustrates the relationship between A/D code and input voltage for a unipolar input range (VFS = Full scale input voltage).

A/D Code	Input Voltage Symbolic Formula	Input Voltage for $0-5V$ Range
-32768	0V	0.0000V
-32767	1 LSB (V_{FS} / 65536)	0.000076V
...	...	...
-1	V_{FS} / 2 - 1 LSB	2.4999V
0	V_{FS} / 2	2.5000V
1	V_{FS} / 2 + 1 LSB	2.5001V
...	...	...
32767	V_{FS} - 1 LSB	4.9999V

14. A/D SCAN, INTERRUPT AND FIFO OPERATION

The control bits SCANEN (scan enable) and AINTE (A/D interrupt enable) in conjunction with the FIFO determine the behavior of the board during A/D conversions and interrupts.

At the end of an AD conversion, the 16-bit A/D data is latched into the 8-bit FIFO in an interleaved fashion: first LSB, then MSB. A/D Data is read out of the FIFO with 2 read operations, first Base + 0 (LSB) and then Base + 1 (MSB).

When SCANEN = 1, each time an A/D trigger occurs, the board will perform an A/D conversion on all channels in the channel range programmed in Base + 2. When SCANEN = 0, each time an A/D trigger occurs, the board will perform a single A/D conversion and then advance to the next channel and wait for the next trigger.

During interrupt operation (AINTE = 1), the FIFO will fill up with data until it reaches the threshold programmed in the FIFO threshold register, and then the interrupt request will occur. If AINTE = 0, the FIFO threshold is ignored and the FIFO continues to fill up.

If the FIFO reaches its limit of 48 samples, then the next time an A/D conversion occurs the Overflow flag OVF will be set. In this case the FIFO will not accept any more data, and its contents will be preserved and may be read out. In order to clear the overflow condition, the program must reset the FIFO by writing to the FIFORST bit in Base + 1, or a hardware reset must occur.

In Scan mode (SCANEN = 1), the FIFO threshold should be set to a number at least equal to the scan size and in all cases equal to an integral number of scans. For example if the scan size is 8 channels, the FIFO threshold should be set to 8, 16, 24, 32, 40, or 48, but not less than 8. This way the interrupt will occur at the end of the scan, and the interrupt routine can read in a complete scan or set of scans each time it runs.

In non-scan mode (SCANEN = 0), the FIFO threshold should be set to a level that minimizes the interrupt rate but leaves enough time for the interrupt routine to respond before the next A/D conversion occurs. Remember that no data is available until the interrupt occurs, so if the rate is slow the delay to receive A/D data may be long. Therefore for slow sample rates the FIFO threshold should be small. If the sample rate is high, the FIFO threshold should be high to reduce the interrupt rate. However remember that the remaining space in the FIFO determines the time the interrupt routine has to respond to the interrupt request. If the FIFO threshold is too high, the FIFO may overflow before the interrupt routine responds. A good rule of thumb is to limit the interrupt rate to no more than 1,000-2,000 per second in Windows and Linux or 10,000 per second in DOS. Experimentation may be necessary to determine the optimum FIFO threshold for each application.

The table on the next page describes the board's behavior for each of the 4 possible cases of AINTE and SCANEN. The given interrupt software behavior describes the operation of the Diamond Systems Universal Driver software. If you write your own software or interrupt routine you should conform to the described behavior for optimum results.

The following table describes the register settings for the A/D operating modes. (LOW and HIGH channels referenced in the table are the 4-bit channel numbers in Base+2.)

AINTE Base+4, bit 0	SCANE Base+2, bit 1	Operation
0	0	Single A/D conversions are triggered by write to B+0. STS stays high during the A/D conversion. No interrupt occurs. The user program monitors STS (Base+3, bit 7) and reads A/D data when STS goes low.
0	1	A/D scans are triggered by write to B+0. All channels between LOW and HIGH are sampled. STS stays high during the entire scan (multiple A/D conversions). No interrupt occurs. The user program monitors STS (Base+3, bit 7) and reads A/D data when STS goes low.
1	0	Single A/D conversions are triggered by the source selected with ADCLK (Base+4, bit 4). STS stays high during the A/D conversion. A/D interrupt occurs when the FIFO reaches its programmed threshold. The interrupt routine reads the number of samples equal to the FIFO threshold (Base+5, bits 0-5).
1	1	A/D scans are triggered by the source selected with ADCLK (Base+4, bit 4). STS stays high during the entire scan (multiple A/D conversions). A/D interrupt occurs when the FIFO reaches its programmed threshold. The interrupt routine reads the number of samples equal to the FIFO threshold (Base+5, bits 0-5).

15. DIGITAL-TO-ANALOG OUTPUT RANGES AND RESOLUTION

15.1 Description

Athena II uses a 4-channel 12-bit D/A converter (DAC) to provide four analog outputs. A 12-bit DAC can generate output voltages with the precision of a 12-bit binary number. The maximum value of a 12-bit binary number is 2^{12} - 1, or 4095, so the full range of numerical values that the DACs support is 0 - 4095. The value 0 always corresponds to the lowest voltage in the output range, and the value 4095 always corresponds to the highest voltage minus 1 LSB. The theoretical top end of the range corresponds to an output code of 4096 which is impossible to achieve.

> **Note:** In this manual, the terms analog output, D/A, and DAC are all used interchangeably to mean the conversion of digital data originating from the Athena II computer hardware to an analog signal terminating at an external source.

15.2 Resolution

The resolution is the smallest possible change in output voltage. For a 12-bit DAC the resolution is $1/(2^{12})$, or 1/4096, of the full-scale output range. This smallest change results from an increase or decrease of 1 in the D/A code, so this change is referred to as 1 least significant bit (1 LSB). The value of this LSB is calculated as follows.

$$1\ LSB = Output\ voltage\ range\ /\ 4096$$

Example:

For, Output range = 0-10V,

$$Output\ voltage\ range = 10V - 0V = 10V$$

Therefore,

$$1\ LSB = 10V\ /\ 4096 = 2.44mV$$

Example:

For, Output range = $\pm$10V;

$$Output\ voltage\ range = 10V - (-10V) = 20V$$

Therefore,

$$1\ LSB = 20V\ /\ 4096 = 4.88mV$$

15.3 Output Range Selection

Jumper block J13 is used to select the DAC output range. The DACs can be configured for 0-10V or $\pm$10V.

Two parameters are configured:
- unipolar/bipolar mode
- power-up/reset clear mode.

In most cases, for unipolar mode configure the board to reset to zero scale, and for bipolar mode configure the board for reset to mid-scale. In each case, the DACs reset to 0V.

15.4 D/A Conversion Formulas and Tables

The formulas below explain how to convert between D/A codes and output voltages.

15.4.1 D/A Conversion Formulas for Unipolar Output Ranges

Output voltage = (D/A code / 4096) * Reference voltage

D/A code = (Output voltage / Reference voltage) * 4096

Example:

For,

Output range in unipolar mode = 0 – 10V,

and,

Full-scale range = 10V – 0V = 10V,

if,

Desired output voltage = 2.000V,

D/A code = 2.000V / 10V * 4096 = 819.2 => 819

Note: the output code is always an integer.

For the unipolar output range 0-10V, 1 LSB = 1/4096 * 10V = 2.44mV.

The following table illustrates the relationship between D/A code and output voltage for a unipolar output range (VREF = Reference voltage).

D/A Code	Output Voltage Symbolic Formula	Output Voltage for 0-10V Range
0	0V	0.0000V
1	1 LSB (V_{REF} / 4096)	0.0024V
...	...	...
2047	V_{REF} / 2 - 1 LSB	4.9976V
2048	V_{REF} / 2	5.0000V
2049	V_{REF} / 2 + 1 LSB	5.0024V
...	...	...
4095	V_{REF} - 1 LSB	9.9976V

15.4.2 D/A Conversion Formulas for Bipolar Output Ranges

> *Output voltage = ((D/A code – 2048) / 2048) * Output reference*

> *D/A code = (Output voltage / Output reference) * 2048 + 2048*

Example:

For,

> *Output range in bipolar mode = ±10V*

and,

> *Full-scale range = 10V – (-10V) = 20V*

if,

> *Desired output voltage = 2.000V*

> *D/A code = 2V / 10V * 2048 + 2048 = 2457.6 => 2458*

For the bipolar output range $\pm10V$, 1 LSB = 1/4096 * 20V, or 4.88mV.

The following table illustrates the relationship between D/A code and output voltage for a bipolar output range (VREF = Reference voltage).

D/A Code	Output Voltage Symbolic Formula	Output Voltage for ±10V Range
0	$-V_{REF}$	-10.0000V
1	V_{REF} + 1 LSB	-9.9951V
...	...	...
2047	-1 LSB	-0.0049V
2048	0	0.0000V
2049	+1 LSB	0.0049V
...	...	...
4095	V_{REF} - 1 LSB	9.9951V

16. GENERATING AN ANALOG OUTPUT

There are three steps involved in performing a D/A conversion, or generating an analog output. Each step is described in more detail, below. The descriptions use direct programming instead of driver software.

Compute the D/A code for the desired output voltage.
   12. Write the value to the selected output channel.
   13. Wait for the D/A to update.

16.1   Compute the D/A Code for the Desired Output Voltage

Use the formulas in the preceding section to compute the D/A code required to generate the desired voltage.

> **Note:** The DAC cannot generate the actual full-scale reference voltage; to do so would require an output code of 4096, which is not possible with a 12-bit number. The maximum output value is 4095. Therefore, the maximum possible output voltage is always 1 LSB less than the full-scale reference voltage.

16.2   Write the Value to the Selected Output Channel Registers

Use the following formulas to compute the LSB and MSB values.

LSB = D/A Code & 255 ;keep only the low 8 bits

MSB = int(D/A code / 256) ;strip off low 8 bits, keep 4 high bits

Example:

For,

Output code = 1776

Compute,

LSB = 1776 & 255 = 240 (0xF0)

and

MSB = int(1776 / 256) = int(6.9375) = 6

The LSB is an 8-bit number in the range 0-255. The MSB is a 4-bit number in the range 0-15.

The MSB is always rounded *down.* The truncated portion is accounted for by the LSB.

Write these values to the selected channel. The LSB is written to Base+6. The MSB and channel number are written to Base+7 (MSB = bits 0-3, channel number,0-3 = bits 6-7).

```
outp(Base+6, LSB);
outp(Base+7, MSB + channel << 6);
```

16.3   Wait for the D/A to Update

Writing the MSB and channel number to Base+7 starts the D/A update process for the selected channel. The update process requires approximately 30 microseconds to transmit the data serially to the D/A chip and update the D/A circuit in the chip. During this period, no attempt should be made to write to any other channel in the D/A through addresses Base+6 or Base+7.

The status bit DACBUSY (Base+3, bit 4) indicates if the D/A is busy updating (1) or idle (0). After writing to the D/A, monitor DACBUSY until it is zero before continuing with the next D/A operation.

17. ANALOG CIRCUIT CALIBRATION

The Athena II data acquisition circuit contains an advanced autocalibration circuit that can maintain the accuracy of both A/D and D/A circuits to within the specified tolerances regardless of time and temperature. Autocalibration is supported in the Diamond Systems Universal Driver software included with the board.

The autocalibration circuit uses an ultra-stable +5V reference voltage IC as the source for its calibration. Both A/D and D/A circuits are calibrated in the analog domain by using a series of 8-bit "TrimDACs" to adjust the offset and gain settings of the circuits. The data values driving the DACs are stored in an EEPROM and are loaded automatically each time the board powers up.

During the autocalibration process, the board will measure the on-board reference and calibrate the A/D circuit by adjusting the TrimDACs to achieve the best accuracy. Once the A/D circuit is calibrated, the D/A circuit is calibrated by routing the D/A outputs into the A/D converter and adjusting them as well. The new calibration values for the TrimDACs are stored back into the EEPROM so they can be automatically recalled thereafter.

A unique feature of Diamond's autocalibration process is that each analog input range is individually calibrated for optimum performance. Analog amplifier circuits with 16-bit accuracy exhibit gain and offset errors that vary depending on the gain setting. The settings that work best for one range may not be sufficient to calibrate another. If a circuit is calibrated for maximum accuracy in a particular input range, such as +/-5V, changing the input range to +/-10V or 0-2.5V may introduce errors that exceed the resolution of a 16-bit measurement and will require calibration again.

To counteract this phenomenon, Diamond's autocalibration circuit provides for a separate complete set of calibration settings for each analog input range. During the autocalibration process, each range is calibrated one at a time, and its set of calibration settings is stored in a separate area of the EEPROM's memory. One of these ranges is identified as the "boot range", and this range's calibration values are the ones that are automatically recalled during power-up. You have the option of specifying the boot range, which should be chosen as the range most commonly used in your application. When you change the input range, you have the option of loading the calibration values for the new input range to maintain optimum accuracy of your measurements.

The autocalibration process is triggered with a single function call in the Diamond Universal Driver software. The process takes about 10-20 seconds to calibrate the complete set of analog input ranges and about the same time for the D/A circuit. Autocalibration can easily be incorporated into your application program, so that you can calibrate the data acquisition circuit as often as necessary while your system is running.

18. DIGITAL I/O OPERATION

Athena II contains 24 digital I/O lines organized as three 8-bit I/O ports: Port A, Port B, and Port C. The direction of each port is programmable, and port C is further divided into two 4-bit halves, each with independent direction. The port data are accessed at registers Base+8 through Base+10, and the port direction register is located at Base+11.

Base +	7	6	5	4	3	2	1	0
8	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
9	PB7	PB6	PB5	PB4	PB3	PB2	PB1	PB0
10	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
11	DIOCTR	-	-	DIRA	DIRCH	-	DIRB	DIRCL

The digital I/O lines are located at pins 1 through 24 on the I/O header J14. The lines are 3.3V and 5V logic compatible. Each output is capable of supplying –8mA in logic 1 state and +12mA in logic 0 state.

DIRA, DIRB, DIRCH, and DIRCL control the direction of ports A, B, C4-7 and C0-3. A direction value of 0 means output and 1 means input. All ports power up to input mode and the output registers are cleared to zero. When a port direction is changed to output, its output register is cleared to zero. When a port is in output mode, its value can be read back.

DIOCTR is used to control the function of lines C7-C4 on the I/O connector. When DIOCTR = 1, the lines are port C7-C4. When DIOCTR = 0, the lines are used for the counter/timer.

Pin No.	DIOCTR = 1	DIOCTR = 0	Pin direction for DIOCTR = 0
21	C4	Gate0	Input
22	C5	Gate1	Input
23	C6	Clk1	Input
24	C7	Out0	Output

19. COUNTER/TIMER OPERATION

Athena II contains two counter/timers that provide various timing functions on the board for A/D timing and user functions. These counters are controlled with registers in the on-board data acquisition controller FPGA.

19.1 Counter 0 – A/D Sample Control

Counter 0 is a 24-bit, "divide-by-n" counter used for controlling A/D sampling. The counter has a clock input, a gate input, and an output. The input is a 10MHz or 1MHz clock provided on the board and selected with bit CKFRQ0 in register Base+4, bit 5. The gate is an optional signal that can be input on pin 21 of I/O header J14 when DIOCTR (Base+11, bit 7) is 1. If this signal is not used, the counter runs freely. The output is a positive pulse whose frequency is equal to the input clock divided by the 24-bit divisor programmed into the counter. The output appears on pin 24 of the I/O header when DIOCTR is 1.

The counter operates by counting down from the programmed divisor value. When the counter reaches zero, it outputs a positive-going pulse equal to one input clock period (100ns or 1μs, depending on the input clock selected by CKFRQ0). The counter then reloads to the initial load value and repeats the process, indefinitely.

The output frequency can range from 5MHz (10MHz clock, divisor = 2) to 0.06Hz (1MHz clock divided by 16,777,215, or 2^{24}-1). The output is fed into the A/D timing circuit and can be selected to trigger A/D conversions when Base+4 register bits AINTE is 1 and ADCLK is 0. Using the control register at Base+15, the counter can be loaded, cleared, enabled and disabled. The optional gate can be enabled and disabled, and the counter value can be latched for reading.

19.2 Counter 1 – Counting/Totalizing Functions

Counter 1 is similar to Counter 0 except that it is a 16-bit counter. Counter 1 also has an input, a gate and an output. These signals may be user-provided on the I/O header when DIOCTR is 0, or the input may come from the on-board clock generator. When the on-board clock generator is used, the clock frequency is either 10MHz or 100KHz, as determined by control Base+4 register bit CKFRQ1.

The output is a positive-going pulse that appears on pin 26 of the I/O header. The output pulse occurs when the counter reaches zero. When the counter reaches zero, it reloads and restarts on the next clock pulse. The output stays high for the entire time the counter is at zero; i.e., from the input pulse that causes the counter to reach zero until the input pulse that causes the counter to reload.

When DIOCTR is 0, Counter 1 operates as follows.

- It counts positive edges of the signal on pin 23 on the I/O header.
- The gate is provided on pin 22. If the signal is high, the counter counts. If the signal is low, the counter holds its value and ignore input pulses. This pin has a pull-up so the counter can operate without any external gate signal.

  NOTE: When counting external pulses, Counter 1 only updates its read register every fourth pulse. This behavior is due to the synchronous design of the counter having to contend with the asynchronous input pulses. The count register contents are correct on the fourth pulse but remain static until four additional pulses occur on the input.

When DIOCTR is 1, Counter 1 operates as follows.

  The counter takes its input from the on-board clock generator based on the value of the Base+4 register CKFRQ1 bit. There is no gating and the counter runs continuously.

Counter 1 may be used as either a pulse generator or a totalizer/counter. In pulse generator mode, the output signal on pin 26 is of interest. In totalizer/counter mode, the counter value is of interest and may be read by first latching the value and then reading it. The width of the pulse is equal to the time period of the selected counters clock source.

19.3   Command Sequences

Diamond Systems provides driver software to control the counter/timers on Athena II. The information in this section is intended as a guide for programmers writing their own code, instead of using the driver, and to give a better understanding of the counter/timer operation.

The counter control register is located at I/O address base+15.

19.3.1   Load and Enable (Run) a Counter Sequence

14. Write the data to the counter. For counter 0, three bytes are required to load a 24-bit value. For counter 1, two bytes are needed for a 16-bit value. The value is an unsigned integer.

   Break the load value into 3 bytes: low, middle, and high, (Two bytes for Counter 1) and write the bytes to the data registers in any sequence.

```
Counter 0:                     Counter 1:
     outp(base+12,low);            outp(base+12,low);
     outp(base+13,middle);         outp(base+13,high);
     outp(base+14,high);
```

15. Load the counter.

```
Counter 0:                     Counter 1:
     outp(base+15,0x02);           outp(base+15,0x82);
```

16. Enable the gate if desired. The gating may be enabled or disabled at any time. When gating is disabled, the counter counts all incoming edges. When gating is enabled, if the gate is high the counter counts all incoming edges and, if the gate is low, the counter ignores incoming clock edges.

```
Counter 0:                     Counter 1:
     outp(base+15,0x10);           outp(base+15,0x90);
```

17. Enable the counter. A counter may be enabled or disabled at any time. If disabled, the counter ignores incoming clock edges.

```
Counter 0:                     Counter 1:
     outp(base+15,0x04);           outp(base+15,0x84);
```

19.3.2   Read a Counter Sequence

18. Latch the counter.

```
Counter 0:                     Counter 1:
     outp(base+15,0x40);           outp(base+15,0xC0);
```

19. Read the data.

   The value is returned in 3 bytes, low, middle, and high (2 bytes for counter 1).

```
Counter 0:                     Counter 1:
     low=inp(base+12);             low=inp(base+12);
     middle=inp(base+13);          high=inp(base+13);
     high=inp(base+14);
```

20. Assemble the bytes into the complete counter value.

```
Counter 0:                                Counter 1:
     val = high * 2^16 + middle * 2^8 + low;   val = high * 2^8 + low;
```

19.3.3   Disabling the Counter Gate Command

- Disabling the counter gate, as shown below, causes the counter to run continuously.

Counter 0:   Counter 1:
```
        outp(base+15,0x20);        outp(base+15,0xA0);
```

19.3.4 Clearing a Counter Sequence

Clear a counter to restart an operation. Normally, a counter is only cleared after stopping (disabling) and reading the counter. If you clear a counter while it is enabled, it continues to count incoming pulses so the counter value may not remain at zero.

21. Stop (disable) the counter.

Counter 0:   Counter 1:
```
        outp(base+15,0x08);        outp(base+15,0x88);
```

22. Read the data (optional).

The value is returned in 3 bytes, low, middle, and high (2 bytes for counter 1).

Counter 0:   Counter 1:
```
        low=inp(base+12);          low=inp(base+12);
        middle=inp(base+13);       high=inp(base+13);
        high=inp(base+14);
```

23. Clear the counter.

Counter 0:   Counter 1:
```
        outp(base+15,0x01);     outp(base+15,0x81);
```

20. WATCHDOG TIMER PROGRAMMING

Athena II contains a watchdog timer circuit consisting of one programmable timer. The input to the circuit is WDI and the output is WDO, which appear on connector J6. WDI may be triggered in hardware or in software. A special "early" version of WDO may be output on the WDO pin. When this signal is connected to WDI, the watchdog circuit is retriggered automatically.

The watchdog timer duration is user-programmable. When WDT is triggered, it begins to count down. Upon reaching zero, it generates a user-selectable combination of the following events.

- System management interrupt
- Hardware reset

The watchdog timer circuit is programmed using I/O registers located at address 0x25C. Detailed programming information is described, below. The Athena II watchdog timer is supported in the DSC Universal Driver software version 5.7 and later.

20.1 Watchdog Timer Register Details

The registers in the following table are used to program the watchdog timer.

I/O Address	Write Function	Read Function
0x25C	WDT trigger	None, write-only
0x25D	WDT, counter	None, write-only
0x25E	Watchdog control	Readback
0x25F	Chip select enable/disable	Readback the last bits written

In the tables, below, a blank bit (-) indicates the bit is unused. A blank bit in the read registers reads back as 0 or 1, unknown state.

I/O Address: 0x25C (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	-			WDTRIG	-			

WDTRIG   Writing a 1 triggers an immediate software reload of the watchdog timer.

I/O Address: 0x25D (Write)

Bit:	7	6	5	4	3	2	1	0
Name:	WDT3	WDT2	WDT1	WDT0	-			

WDT4-7   Writing to bits WDT4-7 loads the watchdog timer with the 4-bit counter value. Use this register to set the countdown period. Each tick is 145ms, so the period range is 145ms to 2.175 seconds (1 to 15).

I/O Address: 0x25E (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	WDIEN	WDOEN	WDSMI	WDEDGE	-			

WDIEN   0 = Disable edges on the WDI pin, retriggering watchdog timer.

1 = Enable edges on the WDI pin retriggering watchdog timer.

WDOEN   0 = Disable edge on WDO pin when watchdog timer reaches 1.

1 = Enable edge on WDO pin when watchdog timer reaches 1.

WDSMI   0 = Disable system management interrupt signal when watchdog timer reaches 0.

1 = Enable system management interrupt signal when watchdog timer reaches 0.

WDEDGE 0 = Falling edge on WDI retriggers watchdog timer, when WDIEN = 1.

1 = Rising edge on WDI retriggers watchdog timer, when WDIEN = 1.

I/O Address: 0x25F (Read/Write)

Bit:	7	6	5	4	3	2	1	0
Name:	COM4EN	COM3EN	FPGAEN	WDEN	-			

COM4EN   COM4 chip select enable.

1 = Enable COM4-CS#.

0 = Disable COM4-CS#.

COM3EN   COM3 chip select enable.

1 = Enable COM3-CS#.

0 = Disable COM3-CS#.

FPGAEN   FPGA chip select enable.

1 = Enable FPGA-CS#.

0 = Disable FPGA-CS#.

WDEN   Watchdog enable.

1 = Watchdog timer counter enable.

0 = Watchdog timer counter disable, WDO disable, WDI disable, CPURST# disable, EXTSMI# disable.

The CPLD initializes all values to zero on power up, and the BIOS enables each resource based on BIOS settings.

20.2   Example: Watchdog Timer With Software Trigger

A software trigger relies on a thread of execution to constantly trigger watchdog timer A.   If the thread is ever halted, timer A decrements to zero and starts timer B. Once timer B decrements to 0, the board resets.

In this example we set the watchdog timer to a countdown period of four seconds.   Longer timeout periods are typically be used for a software-based watchdog timer, to accommodate varying software latencies, such as interrupt latencies and thread pre-emption that may delay the watchdog trigger code.

Setting up the watchdog timer:

```
outp ( 0x25D, 0xF0 );   // set all 4-bits in Watchdog Timer to 1 (time setting)

outp ( 0x25E, 0x00 );   // WDIEN=0, WDOEN=0, WDSMI=0, WDEDGE=0

BYTE b = inp ( 0x25F ); // read in the register value

b |= 0x10;           // WDEN=1

outp ( 0x25F, b );      // enable Watchdog Timer

outp ( 0x25C, 0x10 );   // trigger Watchdog Timer
```

Once triggered, the timer will count down. With the timer setup and active, run the watchdog timer trigger in a continuous thread of code.

```
while (1)
{
        outp( 0x25C, 0x10 );     //trigger watchdog timer
        sleep(1000);                        //sleep one second
}
```

If this thread is interrupted for any reason, the board resets four seconds after the last watchdog timer trigger.

20.3   Example: Watchdog Timer With Hardware Trigger

A hardware trigger relies on an external pulse to constantly trigger watchdog timer A. If the external stream of pulses ever halts, timer A decrements to zero and starts timer B. Once timer B decrements to 0, the board resets.

In this example, we will make use of the T-1 feature of timer A to automatically reset itself unless a physical connection is broken. The physical connection must be made between WDO and WDI on the data acquisition header, J9.

Since software is not involved in maintaining the timer, we can set the reset period to a much smaller value. In this example, the reset pulse travels across the physical connection every 10 milliseconds.

```
outp ( 0x25D, 0xFF); // set all 4-bits in Watchdog Timer to 1 (time setting)

outp ( 0x25E, 0xF0); // set hardware to trigger the Watchdog Timer

BYTE b = inp ( 0x25F ); // read in the register value

b |= 0x10; // WDEN=1

outp ( 0x25F, b ); // enable Watchdog Timer
```

When timer A reaches 1, a rising edge flows from WDO to WDI, resetting the timer back to 100 and lowering WDO.

When the connection from WDO to WDI is broken, the rising edge never reaches WDI and system resets.

21. DATA ACQUISITION SPECIFICATIONS (DATA ACQUISITION UNITS ONLY)

21.1 Analog Inputs

- No. of inputs: 8 differential or 16 single-ended (user selectable)
- A/D resolution: 16 bits (1/65,536 of full scale)
- Input ranges,
- Bipolar: ±10V, ±5V, ±2.5V, ±1.25V
- Unipolar: 0-10V, 0-5V, 0-2.5V
- Input bias current: 50nA max
- Maximum input voltage: ±10V for linear operation
- Over-voltage protection: ±35V on any analog input without damage
- Nonlinearity: ±2LSB, no missing codes
- Drift: 10PPM/^oC typical
- Conversion rate: 100,000 samples per second max
- Conversion trigger: software trigger, internal pacer clock, or external TTL signal
- FIFO: 2048 samples, programmable interrupt threshold

21.2 Analog Outputs

- No. of outputs: 4
- D/A resolution: 12 bits (1/4096 of full scale)
- Output ranges,
- Unipolar: 0-10V or user-programmable
- Bipolar: ±10V or user-programmable
- Output current: ±5mA max per channel
- Settling time: 4µS max to ±1/2 LSB
- Relative accuracy: ±1 LSB
- Nonlinearity: ±1 LSB, monotonic

21.3 Digital I/O

- No. of lines: 24
- Compatibility: 3.3V and 5V logic compatible
- Input voltage: Logic 0: -0.5V min, 0.8V max; Logic 1: 2.0V min, 5.5V max
- Input current: ±1µA max
- Output voltage: Logic 0: 0.0V min, 0.4V max; Logic 1: 2.4V min, 3.3V max
- Output current: Logic 0: 12mA max; Logic 1: -8mA max
- I/O capacitance: 10pF max

21.4 Counter/Timers

- A/D pacer clock: 24-bit down counter
- Clock source: 10MHz, 1MHz or external signal
- General purpose: 16-bit down counter
- Clock source: 10MHz, 100KHz or external signal

22. FLASHDISK MODULE

Athena II is designed to accommodate an optional solid-state FlashDisk module. This module contains 128MB to 4GB of solid-state non-volatile memory that operates like an IDE drive without requiring additional driver software support.

Model	Capacity
FD-128R-XT	128MB
FD-256R-XT	256MB
FD-512R-XT	512MB
FD-1GR-XT	1GB
FD-2GR-XT	2GB
FD-4GR-XT	4GB

FlashDisk Module

22.1   Installing the FlashDisk Module

The FlashDisk module installs directly on the IDE connector, J16, and is held down with a spacer and two screws onto a mounting hole on the board.

The FlashDisk module contains a jumper for master/slave configuration. For master mode, install the jumper over pins 1 and 2. For slave mode, install the jumper over pins 2 and 3.

22.2   Configuration

To configure the CPU to work with the FlashDisk module, enter the BIOS by pressing F2 during startup. Select the Main menu, and then select *IDE Primary Master*. Enter the settings shown in the following table.

Setting	Value
Type	User
Cylinders	489 for 32MB flashdisk
Heads	4 for 32MB flashdisk
Sectors	32 for 32MB flashdisk
Multi Sector Transfer	Disable
LBA Mode Control	Enable
32 Bit I/O	Disable
Transfer Mode	Fast PIO 1
Ultra DMA Mode	Disable

Exit the BIOS and save the change. The system will now boot and recognize the FlashDisk module as drive *C:*.

22.3   Using the FlashDisk with Another IDE Drive

The FlashDisk occupies the board's 44-pin IDE connector and does not provide a pass-through connector. To utilize both the FlashDisk and a notebook drive, the Diamond Systems ACC-IDEEXT adapter and cables are required.

22.4   Power Supply

The 44-pin cable carries power from the CPU to the adapter board and powers the FlashDisk module and any drive using a 44-pin connector, such as a notebook hard drive.

A drive utilizing a 40-pin connector, such as a CD-ROM or full-size hard drive, requires an external power source through an additional cable. The power may be provided from the CPU's power out connector, J12, or from one of the two 4-pin headers on the ACC-IDEEXT board. Athena II cable no. 698006 may be used with either power connector to bring power to the drive.

23. FLASHDISK PROGRAMMER BOARD

The FlashDisk Programmer Board accessory, model number ACC-IDEEXT, may be used for several purposes. Its primary purpose is to enable the simultaneous connection of both a FlashDisk module and a standard IDE hard drive or CD-ROM drive, to allow file transfers to/from the FlashDisk. This operation is normally done at system setup. The board can also be used to enable the simultaneous connection of two drives to the SBC.

Connector J1 connects to the IDE connector on Athena II with a 44-pin ribbon cable (Diamond Systems part number 698004). Both 40-pin .1-inch spacing, J4, and 44-pin 2mm spacing, J3, headers are provided for the external hard drive or CD-ROM drive. A dedicated connector, J2, is provided for the FlashDisk module. Any two devices may be connected simultaneously using this board with proper master/slave jumper configurations on the devices.

The FlashDisk Programmer Board comes with a 44-wire cable no. (DSC number 698004) and a 40-wire cable no. (DSC number C-40-18) for connection to external drives. The FlashDisk module is sold separately.

The 44-pin connector (J1, J2 and J3) and mating cable carry power, but the 40-pin connector (J4) and mating cable do not.   Connectors J5 and J6 on the accessory board may be used to provide power to a 44-pin device attached to the board when the board is attached to a PC via a 40-pin cable. These headers are compatible with the floppy drive power connector on a standard PC internal power cable.

FlashDisk Programmer Board Layout
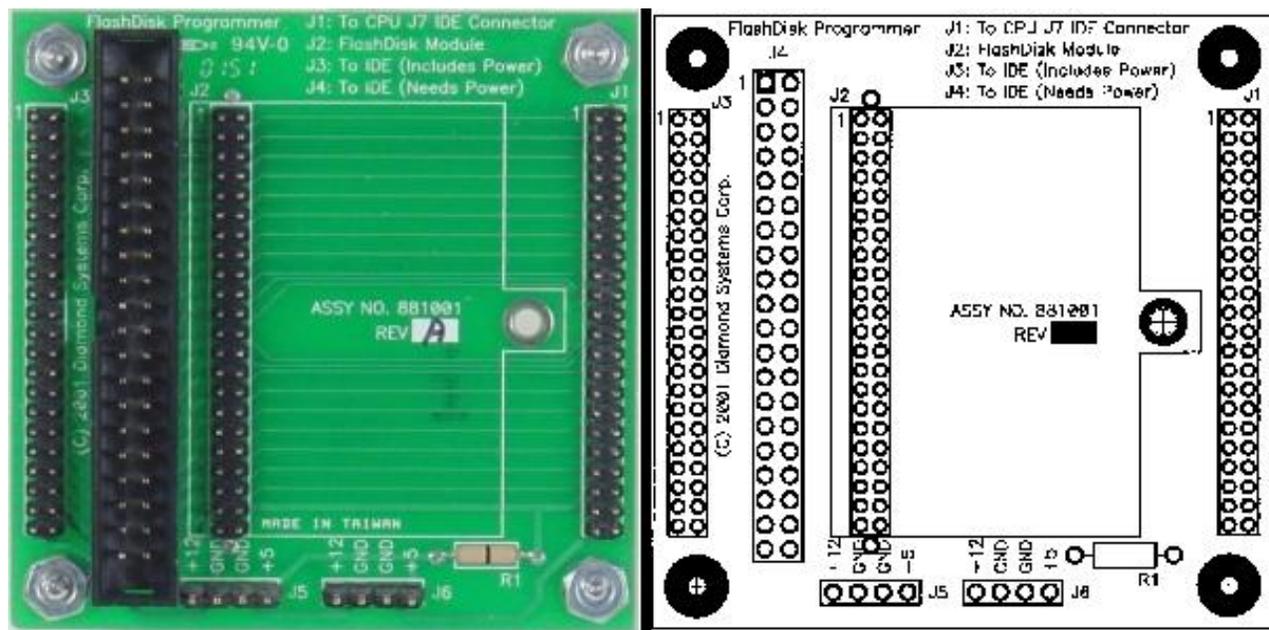
24. I/O CABLES

Diamond Systems offers cable kit C-ATH-KIT with ten cables to connect to all I/O headers on the board, shown in the figure below. Some cables are also available separately.

Cable Kit C-ATH-KIT
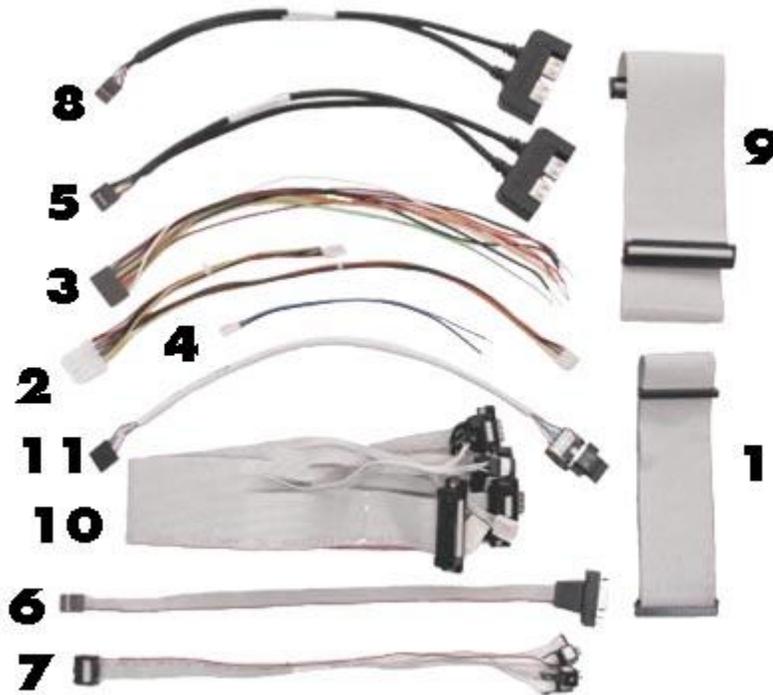
Photo No.	Cable No.	Description
1	6981004	IDE, 44 conductor 2mm ribbon cable
2	6981006	Power output cable
3	6981009	Power input cable
4	6981011	External battery cable
5	6981012	Dual USB cable, ports 0 & 1
6	6981030	VGA cable
7	6981031	Audio cable
8	6981032	Dual USB cable, ports 2 & 3
9	C-50-18	Data acquisition, 50 conductor .1" ribbon cable
10	C-PRZ-01	80-wire / 2-cable breakout cable assembly with serial, parallel, PS/2 mouse/keyboard, power, reset, speaker, & LED connectors
11	C-PRZ-02	Ethernet cable

25. QUICK START GUIDE

This section describes the steps needed to get your Athena II board up and running, and assumes that you have also purchased the Athena II Development Kit. The development kit includes all cables described in the previous section, a power supply, USB floppy drive, mounting hardware, IDE flashdisk and the flashdisk programmer board. More details about the development kit can be found at the following website:

http://www.diamondsystems.com/products/athenaii#dk

25.1 General Setup

This section describes the initial setup procedures, which are identical regardless of which operating system or IDE configuration you are using.

1. Remove the Athena II single board computer from its packaging.
2. Install the mounting kit standoffs into the PC/104 mounting holes located at each corner of the board. This ensures that the board will not touch the surface beneath it, and helps redistribute the force when you push connectors onto the board.
3. Attach the high-density ribbon cable, C-PRZ-01, to locking connector J3. Be sure the cable is inserted snugly and the connector has locked. If you have a PS/2 mouse and keyboard, attach them to the corresponding connectors on C-PRZ-01.
4. Attach the VGA cable, 6981030, to connector J25. Connect your monitor VGA cable to the DB9 socket.
5. Take the power supply out of its packaging. (Do not plug it into the wall yet). Plug the 9-pin connector into the J11 connector on the board, immediately below the PC/104 bus. Be sure the red wire, +5 VDC, goes to pin 1.
6. (Optional for Ethernet) Plug cable C-PRZ-02 into connector J4. You can use the RJ-45 socket on the C-PRZ-02 cable to patch Athena II into your network.
7. (Optional for USB Devices) You will need to connect the USB cables if you are going to use a USB floppy, keyboard or mouse. Plug USB cable 6981012 into connector J5. If you need 3 or 4 USB sockets, connect cable 6981032 to connector J21.

25.2 IDE Configuration

Athena II has a single IDE channel that can support up to two devices simultaneously (Master and Slave). IDE devices connect through J8, which is a 44-pin, laptop IDE connector. The following are a few example setups.

1. Connect one IDE flashdisk connected directly to J8.
2. Connect one laptop IDE hard drive directly to J8 through a 44-pin ribbon cable. This cable is available in the cable kit (cable 6981004).
3. Use cable 6981004 to connect an IDE flashdisk programmer board to J8. You can then connect other 40-pin or 44-pin IDE compatible devices to the programmer board. Use cable 6981006, attached to J12, to provide power from the Athena II board to 40-pin devices. Remember, the Athena II cannot generate 12VDC. You will need to supply your own 12VDC line to the IDE device, or through the Athena II power input connector.

25.3   Booting into MS-DOS, FreeDOS or ROM-DOS

This section describes how to boot into a DOS-based operating system using a bootable floppy disk.

1. Plug the USB floppy drive into one of the USB terminals of cable 6981012. (Refer to step 7, above.)
2. Insert your DOS-based boot disk into the USB floppy drive.
3. Connect the power supply to the wall (to provide power to Athena II).
4. At this point the Athena II will boot and you should see the BIOS power-on self test. Press F2 to enter BIOS configuration.
5. Under the "Advanced" menu, scroll to "Legacy USB Support" and enable it. (Without enabling this option, the BIOS will not boot from a disk in the USB floppy drive).
6. Reboot the system to boot from your floppy disk.

25.4   Booting into Linux or Microsoft Windows

This section describes how to setup the Athena II board in preparation for a Linux or Windows install, from an installation CD-ROM onto a laptop IDE hard drive.

1. Connect the IDE FlashDisk programmer board to J8.
2. Connect a CD-ROM drive jumpered for the slave position to the IDE FlashDisk programmer board through the 40-pin cable.
3. Connect power to the CD-ROM drive using cable 6981006 attached to J12. Be sure that an external 12VDC source is being supplied to J11.
4. Connect a laptop hard drive jumpered for master position to the second slot of the 44-pin cable.
5. Boot the Athena II by plugging the power supply into the wall.
6. Press F2 at the power-on self test to go to the BIOS configuration screen.
7. Go to the "Boot" menu and confirm that the CD-ROM drive is first boot device.
8. Insert the boot CD for your operating system into the CD-ROM drive.
9. Save the BIOS settings and reboot.
10. You should now be able to install your OS.

26. SPECIFICATIONS

26.1 CPU

- Processor: VIA Mark CoreFusion
- Speed: 500 or 800MHz
- Power consumption: 10W
- Cooling: Heat sink with fan
- Operating Temperature: -40ºC to +85ºC on most models, -40ºC to +71ºC on two models
- Chipset: VIA VT8606 (Mark internal) and 82C686B
- System Bus: 100MHz
- SDRAM memory: 256MB 533MHz DDR2 soldered on-board
- Bus interface: PC/104 (ISA)
- Display type: CRT and/or 18-bit dual channel LVDS flat panel
- CRT resolution: 1600 x 1200
- Flat Panel Resolution : UXGA 1600 x 1200
- Video memory: 32MB UMA
- USB ports: 4 USB 1.1
- Serial ports: 2 RS-232 and 2 RS-232/485
- Networking: 10/100Base-T Ethernet
- Mass storage interfaces: 1 IDE UDMA 33 with flashdisk interface
- Keyboard/mouse: PS/2
- Audio: AC '97, Line-in, Line-Out,, Mic

26.2 Data Acquisition Circuitry

- Analog inputs: 16 single-ended, 8 differential; user selectable
- A/D resolution: 16 bits
- Bipolar ranges: ±10V, ±5V, ±2.5V, ±1.25V
- Sample rate: 100KHz maximum total
- Unipolar ranges: 0-10V, 0-5V, 0-2.5V, 0-1.25V
- Input bias current: 100pA max
- Protection: ±35V on any analog input without damage
- Input Impedance: 10^{13} ohms
- Relative accuracy: ±2 LSB after autocalibration
- Nonlinearity: ±3LSB, no missing codes
- Conversion rate: 100,000 samples/sec. max
- On-board FIFO: 2048 samples, programmable threshold
- A/D and D/A Calibration: Automatic using on-board microcontroller and temperature sensor
- Analog Outputs: 4, 12-bit resolution
- Output ranges: ±5V, ±10V, 0-5V, 0-10V
- Output current: ±5mA max per channel
- Settling time: 7µS max to 0.01%
- Relative accuracy: ±1 LSB
- Nonlinearity: ±1 LSB, monotonic
- Reset: Reset to zero-scale or mid-scale (jumper selectable)
- Waveform buffer: 1,024 samples

- Digital I/O lines: 24 programmable direction in 8-bit ports
- Input voltage: Logic 0: 0.0V min, 0.8V; max Logic 1: 2.0V min, 5.0V max
- Input current: ±1μA max
- Output voltage: Logic 0: 0.0V min, 0.33V; max Logic 1: 2.4V min, 5.0V max
- Output current: Logic 0: 12mA max per line Logic 1: -4mA max per line
- A/D Pacer clock: 24-bit down counter (source: 10MHz, 1MHz or external signal)
- General purpose: 16-bit down counter (source: 10MHz, 100KHz or external signal)

26.3 Power Supply

- Input Voltage: +5VDC ±5%

26.4 General

- Shock: IEC68-2-27
- Vibration: MIL-STD-810E 514.4
- Dimensions: 4.18 x 4.48 in. (106 x 114mm)
- Weight: 4.7oz.(133g) without heatsink

27. ADDITIONAL INFORMATION

Additional information can be found at the following websites:

- Diamond Systems Corporation: http://www.diamondsystems.com/
- VIA Technologies, Inc.: http://www.via.com.tw/en/products/processors/corefusion/mark/index.jsp
- National Semiconductor Corporation: http://www.national.com

28. BIOS CMOS OPTION LISTING

This section describes the steps for modifying the BIOS settings and describes the BIOS screens.

28.1 Viewing and Modifying the BIOS Settings

During board startup, pressing function key <F2> to enter BIOS setup mode.

The main page displays the following menu options:
- Main
- Advanced
- Security
- Power
- Boot
- Exit

Select the menu option to view or modify the BIOS settings for the desired configuration area. The screens displayed for each area are described, below.

The following keyboard controls are available on any page for navigating the screen, as displayed at the bottom of each page.

Key	Function
F1	Help.
Esc	Exit current screen.
up-/down-arrow	Select setup item.
left-/right-arrow	Select menu item.
plus/minus symbols (+/-)	Change values.
Enter	Execute command.
F9	Save default values.
F10	Save changes and exit BIOS setup mode.

At any time, select Exit to exit BIOS setup mode. Use the up/down arrow keys, followed by carriage return, to apply one of the following exit actions.

Exit Action	Description
Exit Saving Changes	Exit BIOS setup mode saving any changes made.
Exit Discarding Changes	Exit BIOS setup mode discarding any changes made
Load Setup Default	Load default BIOS settings, without exiting BIOS setup mode.
Discard Changes	Discard any changes made, without exiting BIOS setup mode.
Save Changes	Save any changes made, without exiting BIOS setup mode.

28.2   BIOS Screen Descriptions

This section describes the screen displays for each BIOS setup area.

Where "Change Not Allowed" is indicated, it is because the configuration item is not supported by the current hardware version. The configuration item is displayed for future expansion.

Main

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
System Time	00:00:00	-	Hours:minutes:seconds; 24-hour format.	-
System Date	00/00/00	-	Month/day/year.	-
Legacy Diskette A:	DISABLED	ENABLED	-	-
Legacy Diskette B:	DISABLED	ENABLED	-	X
Primary Master	-	-	See Primary Master HDD Setup.	-
Primary Slave	-	-	See Primary Slave HDD Setup.	-
Secondary Master	-	-	See Secondary Master HDD Setup.	X
Secondary Slave	-	-	See Secondary Slave HDD Setup.	X
Memory Shadow	-	-	See Memory Shadow Setup.	-
Memory Cache	-	-	See Memory Cache Setup.	-
Quick Boot Mode	ENABLED	DISABLED	-	-
Floppy Check	DISABLED	ENABLED	-	X
System Summary Screen	DISABLED	ENABLED	-	-
System Memory	640KB	-	-	X
Extended Memory	xxxxxxxKB	-	Determined by the BIOS.	X

Primary Master HDD Setup

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Device Type	AUTO	CDROM User ATAPI	Type of device.	-
Cylinders	xxxxxx	-	Number of cylinders; CHS format.	-
Heads	xxxxxx	-	Number of heads; CHS format.	-
Sectors	xxxxxx	-	Number of sectors; CHS format.	-
Maximum Capacity	xxxxxx	-	Always calculated by the BIOS.	X
Total Sector	xxxxxx	-	Total number of sectors; LBA format. Always calculated by the BIOS.	X
Maximum Capacity	xxxxxx	-	Maximum capacity; LBA format. Always calculated by the BIOS.	X
Multi-Sector Transfers	DISABLE	-	-	X
LBA Mode Control	DISABLE	-	-	X
32 bit I/O	DISABLE	ENABLE	-	-
Transfer Mode	DISABLE	-	-	X
Ultra DMA Mode	DISABLE	-	-	X
Smart Monitoring	DISABLE	-	-	X

Primary Slave HDD Setup

This screen is the same as the Primary Master HDD Setup screen.

Secondary Master HDD Setup

This screen is the same as the Primary Master HDD Setup screen.

Secondary Slave HDD Setup

This screen is the same as the Primary Master HDD Setup screen.

Memory Shadow

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
System shadow	Enabled	-	-	X
Video shadow	Enabled	Disabled	-	-

Memory Cache

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Memory Cache	Enabled	Disabled	-	-
Cache System BIOS Area	Write-Protect	Uncached	-	-
Cache Video BIOS Area	Write-Protect	Uncached	-	-
Base 0-512KB	Write-Back	Uncached Write-Through Write-Protect	-	-
Base 512-640KB	Write-Back	Uncached Write-Through Write-Protect	-	-
Extended Memory Area	Write-Back	Uncached Write-Through Write-Protect	-	-
Cache A000-AFFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache B000-BFFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache C800-CBFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache CC00-CFFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache D000-D3FF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache D400-D7FF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache D800-DBFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache DC00-DFFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-

Cache E000-E3FF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache E400-E7FF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache E800-EBFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-
Cache EC00-EFFF	Disabled	USWC Write-Through Write-Protect Write-Back	-	-

28.2.1 Advanced

Note: Setting items on this menu to incorrect values may cause your system to malfunction.

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
PCI Configuration	-	-	See PCI Configuration.	-
Advanced Chipset Control	-	-	See Advanced Chipset Control.	-
I/O Device Configuration	-	-	See I/O Device Configuration.	-
PS/2 Mouse	Auto Detect	Disabled Enabled	-	-
LAN	Disabled	Enabled	-	-
FPGA Mode	Disabled	Enabled	-	-
Boot Video Device	Auto	Both	-	-
LCD Panel Type	7	0-F	-	-
Local Bus IDE Adapter	Both	Disabled Primary Secondary	-	-
Legacy USB Support	Enabled	Disabled	-	-
On-chip Multi-function Device	-	-	See On-chip Multi-function Device.	-
Large Disk Access Mode	DOS	Other	-	-
Installed O/S	Win98	Other Win95 WinME Win2000	-	-
Reset Configuration Data	No	Yes	-	-
Console Redirection	-	-	See Console Redirection.	-
Hardware Monitor	-	-	See Hardware Monitor.	-

PCI Configuration

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
PCI/PNP ISA UMB Region Exclusion	-	-	See PCI/PNP ISA UMB Region Exclusion.	-
PCI/PNP ISA IRQ Resource Exclusion	-	-	See PCI/PNP ISA IRQ Resource Exclusion.	-
PCI/PNP ISA DMA Resource Exclusion	-	-	See PCI/PNP ISA DMA Resource Exclusion.	-
PCI IRQ Line 1	Disabled	Auto Select 3,4,5,6,7,8,9,10, 11,12,13,14,15	-	-
PCI IRQ Line 2	Disabled	Auto Select 3,4,5,6,7,8,9,10, 11,12,13,14,15	-	-
PCI IRQ Line 3	Disabled	Auto Select 3,4,5,6,7,8,9,10, 11,12,13,14,15	-	-
PCI IRQ Line 4	Disabled	Auto Select 3,4,5,6,7,8,9,10, 11,12,13,14,15	-	-

PCI/PNP ISA UMB Region Exclusion

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
C800-CBFF	Available	Reserved	-	-
CC00-CFFF	Available	Reserved	-	-
D000-D3FF	Available	Reserved	-	-
D400-D7FF	Available	Reserved	-	-
D800-DBFF	Available	Reserved	-	-
DC00-DFFF	Available	Reserved	-	-

PCI/PNP ISA IRQ Resource Exclusion

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
IRQ3	Available	Reserved	-	-
IRQ4	Available	Reserved	-	-
IRQ5	Available	Reserved	-	-
IRQ7	Available	Reserved	-	-
IRQ8	Available	Reserved	-	-
IRQ10	Available	Reserved	-	-
IRQ11	Available	Reserved	-	-
IRQ15	Available	Reserved	-	-

PCI/PNP ISA DMA Resource Exclusion

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
DMA0	Available	Reserved	-	-
DMA1	Available	Reserved	-	-
DMA2	Available	Reserved	-	-
DMA3	Available	Reserved	-	-
DMA4	Available	Reserved	-	-
DMA5	Available	Reserved	-	-
DMA6	Available	Reserved	-	-
DMA7	Available	Reserved	-	-

Advanced Chipset Control

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
PCI Delayed Transaction	Enabled	Disabled	-	-
Aperture Size	64M	2M, 4M, 8M, 16M, 32M, 128M, 256M	-	-
Frame Buffer Size	8MB	None 2MB, 4MB, 16MB, 32MB	-	-
AGP Rate	4X	1X 2X	-	-
Expansion Bus Performance	Normal	Accelerated Turbo	-	-

I/O Device Configuration

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Serial Port 1	Enabled	Auto Disabled	-	-
Base I/O Address	3F8	2F8, 3E8, 2E8	-	-
Interrupt	IRQ4	IRQ3	-	-
Mode	Normal	IrDA ASK_IR	-	-
Serial Port 2	Enabled	Auto Disabled	-	-
Base I/O Address	2F8	3F8, 3E8, 2E8	-	-
Interrupt	IRQ3	IRQ4	-	-
Mode	Normal	IrDA ASK_IR	-	-
Serial Port 3	Enabled	Disabled	-	-
Base I/O Address	3E8	-	-	X
Interrupt	IRQ9	IRQ3, IRQ4, IRQ5, IRQ6	-	-
Mode	RS232	RS485	-	-
Serial Port 4	Enabled	Disabled	-	-
Base I/O Address	2E8	-	-	X
Interrupt	IRQ15	IRQ3	-	-
Mode	RS232	RS485	-	-
Parallel Port	Enabled	Auto Disabled	-	-
Mode	ECP	EPP Uni-directional	-	-
Base I/O Address	378	278, 3BC	-	-
Interrupt	IRQ7	IRQ5	-	-
DMA Channel	DMA3	DMA1	-	-
Data Acquisition IRQ	IRQ5	Disabled IRQ4, IRQ6	-	-

On-chip Multi-function Device

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
On-Chip USB 2 Device	Enabled	Disabled	USB ports 2 and 3.	-
Onboard Audio	Enabled	Disabled	-	-
Legacy Audio	Disabled	Enabled	-	-
Sound Blaster	Disabled	Enabled	-	-
MPU-401	Disabled	Enabled	-	-
Joystick	Disabled	Enabled	-	-

Console Redirection

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Continue C.R. after POST	Off	On	-	-
Baud Rate	19.2Kbps	300, 1200, 2400, 9600, 38.4k, 57.6k, 115.2k (bps)	-	-
Console Connection	Direct	Modem	-	-
Console Type	PC ANSI	VT100, VT100 8bit, Pc-ANSI 7bit, VT100+, VT-UTF8	-	-
Flow Control	None	XON-XOFF CTS-RTS	-	-
COM Port Address	Disabled	COM PORT 1 COM PORT 2	-	-
# of Video Pages to Support	1	2-8	-	

Hardware Monitor

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Vcore	xx.xx V	-	Set by CPU.	X
V(2.5V)	xx.xx V	-	Set by CPU.	X
V(3.3V)	xx.xx V	-	Set by CPU.	X
CPUTEMP1	-	-	Set by CPU.	X
CPU FAN SPEED	-	-	(RPM) Set by CPU.	X

28.2.2 Security

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Supervisor Password Is	-	-	Field is clear.	X
User Password Is	-	-	Field is clear.	X
Set Supervisor Password	***...***	-	Enter password.	-
Set User Password	***...***	-	Enter password.	-

28.2.3 Power

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Power Savings	Disabled	Customized Max Power Savings	-	-
Idle Mode	Off	On	-	-
Standby Timeout	Off	1, 2, 4, 6, 8, 12, 16 minutes	-	-
Auto Suspend Timeout	Off	5, 10, 15, 20, 30, 40, 60 minutes	-	-
Hard Disk Timeout	Disabled	10, 15, 30, 45 sec. 1, 2, 4, 6, 8, 10, 15 min.	-	-
Video Timeout	Disabled	10, 15, 30, 45 sec. 1, 2, 4, 6, 8, 10, 15 min.	-	-
Resume on LAN	On	Off	Only active when LAN is enabled.	-
Resume on Time	Off	On	-	-
Resume Time	00:00:00	-	-	-

28.2.4 Boot

Configuration Item	Default Value or User Entry	Optional Values	Comments	Change Not Allowed
Power Savings	Disabled	Customized Max Power Savings	-	-
Boot Sequence	-	Hard Drive CD ROM USB HDD/Floppy Disk Removable Device	The order is selectable using the up/down arrow keys.	-